

SC8P054 User Manual

Enhanced OTP 8-bit CMOS microcontrollers Rev. 1.0.2

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1. Product Description

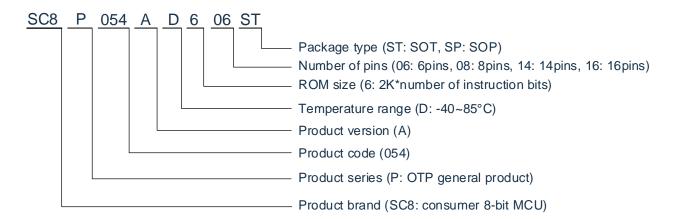
1.1 Features

- Memory
 - OTP: 2K×16Bit
 - Universal RAM: 128×8Bit
- 8-level stack buffer
- Short and clear instruction system (66 instructions)
- Built-in low voltage detection circuit
- ◆ Built-in WDT
- Interrupt sources
 - 2 timer interrupts
 - RA, RB ports interrupt on change
 - Other peripheral interrupts
- ◆ Timer
 - 8-bit timers: TIMER0, TIMER2
 - TIMER2 can select external 32.768Khz oscillating clock source.
- Built-in comparator module
 - Positive: RB1/resistor divider output
 - Negative: RB1/RB2/RB4/RB5/BG/ resistor divider output

- Operating voltage: 3.0V~5.5V@16MHz/2T 1.8V~5.5V@16MHz/4T
 - Operating temperature: -40°C~85°C
- Internal RC oscillation: designed frequency of 16MHz
- Instruction period (single or dual instruction)
- ◆ Built-in PWM module
 - 5-channel PWM with 2 complementary outputs and selectable polarity
 - 4-channel PWM common period, independent duty cycle
 - 1-channel PWM independent period, independent duty cycle
 - 10-bit PWM precision
- ◆ Built-in high-precision 1.2V reference voltage
- ♦ VR can be selected from 1.8V, 2V, 2.5V, 3V



1.2 Product model list

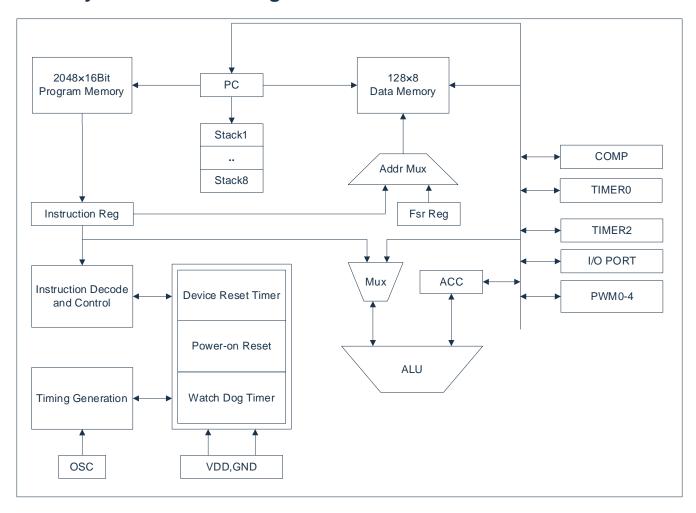


Model description

PRODUCT	ROM	RAM	PWM	ACOMP	I/O	TIMER	PACKAGE
SC8P054AD606ST	2K×16	128×8	3	1	4	2	SOT23-6
SC8P054AD608SP	2K×16	128×8	3	1	6	2	SOP8
SC8P054AD614SP	2K×16	128×8	5	1	12	2	SOP14
SC8P054AD616SP	2K×16	128×8	5	1	14	2	SOP16



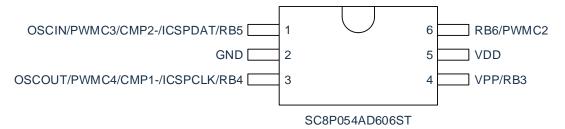
1.3 System structure diagram



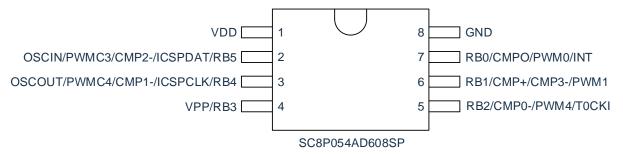


1.4 Top view

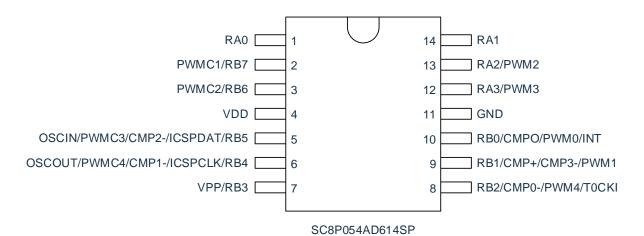
1.4.1SC8P054AD606ST



1.4.2SC8P054AD608SP

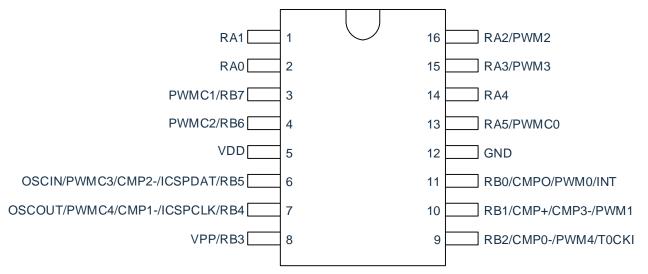


1.4.3SC8P054AD614SP





1.4.4SC8P054AD616SP



SC8P054AD616SP

SC8P054 pin description:

Pin name	IO type	Pin description	
VDD,GND	Р	Supply voltage input pin, ground pin	
RA0-RA5	I/O	Programmable as input pin, push-pull or open-drain output pin, with pull-up and pull-down resistor functionality, and interrupt-on-change function.	
RB0-RB2,RB4-RB7	I/O	Programmable as input pin, push-pull or open-drain output pin, with pull-up resistor functionality, and interrupt-on-change function.	
RB3	I/O	Programmable as input pin, open-drain output pin, with pull-up resistor functionality, and interrupt-on-change function.	
ICSPCLK/ICSPDAT	I/O	Programmable clock/data pin	
VPP	1	Programmable high-voltage input port	
PWM0-PWM4	0	PWM output pin	
PWMC0-PWMC4	0	PWM output pin	
INT	1	External interrupt input pin	
CMP+	1	Comparator positive input pin	
CMP0-, CMP1-, CMP2-, CMP3-	1	Comparator negative input pin	
CMPO	0	Comparator result output pin	
T0CKI	1	TIMER0 external clock input pin	
OSCIN/OSCOUT	I/O	32.768K crystal oscillator input/output pin	



1.5 System configuration register

System Configuration Register (CONFIG) is an OTP option for the MCU initial conditions. It can only be written by the SC programmer and cannot be accessed or manipulated by the user. It contains the following contents.

- 1. WDT (watchdog selection)
 - ◆ ENABLE Enable WDT◆ DISABLE Disable WDT
- 2. PROTECT (encrypted)
 - DISABLE ROM code is not encrypted
 - ♦ ENABLE ROM code is encrypted, and the value read out by the programmed emulator will be uncertain after encryption
- 3. LVR_SEL (low-voltage detection selection)
 - ♠ 1.8V
 - ◆ 2.0V
 - ◆ 2.5V
 - ◆ 3.0V
- 4. F_{CPU}_DIV (instruction clock divison)
 - ◆ 4T Divided by 4, F_{CPU}=F_{SYS}/4
 - 2T Divided by 2, F_{CPU}=F_{SYS}/2



1.6 Online serial programming

The microcontroller can be programmed serially in the final application circuit. Programming can be done simply with the following 5 wires.

- Power wire
- Ground wire
- Data wire
- Clock wire
- High-voltage wire

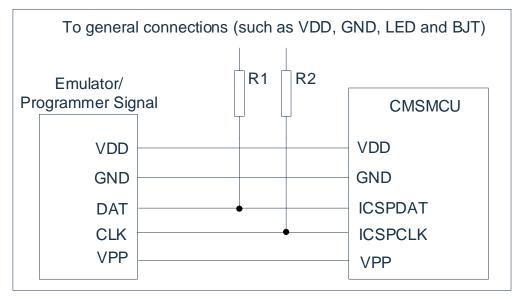


Figure 1-1: Typical connection for online serial programming

In the above figure, R1 and R2 are the electrical isolation devices, normally represented by resistors with the following resistance values: $R1 \ge 4.7K$, $R2 \ge 4.7K$.



2. Central Processing Unit (CPU)

2.1 Memory

2.1.1 Program memory

OTP: 2K

0000H	Reset vector	Program start, jump to user program
0001H		program
0002H		
0003H		
0004H	Interrupt vector	
•••		User program area
•••		
07FDH		
07FEH		
07FFH	Jump to reset vector 0000H	Program end

2.1.1.1 Reset vector (0000H)

The MCU has a 1-byte long system reset vector (0000H). It has 3 ways to reset:

- ♦ Power-on reset
- Watchdog reset
- ◆ Low voltage reset (LVR)

When any above reset happens, program will start to execute from 0000H, system register will be recovered to default value. PD and TO flag bits from the STATUS register can determine which reset is performed from above. The following program illustrates how to define the reset vector from OTP.

Example: define reset vector

	END		;program end
			;user program
START:			
	ORG	0010H	;start of user program
	JP	START	
	ORG	0000H	;system reset vector



2.1.1.2Interrupt vector

The address for interrupt vector is 0004H. Once the interrupt responds, the current value for program counter (PC) will be saved to stack buffer and jump to 0004H to execute interrupt service program. All interrupt will enter 0004H. Users will determine which interrupt to execute according to the bit of the interrupt request flag bit register. The following program illustrates how to write interrupt service program.

Example: define interrupt vector, interrupt program is placed after user program

	ORG	0000H	;system reset vector
			,System reset vector
	JP	START	
	ORG	0004H	start of user program;
INT_START:			
	CALL	PUSH	;save ACC and STATUS
			;user interrupt program
INT_BACK:			
	CALL	POP	;back to ACC and STATUS
	RETI		;interrupt back
START:			·
			;user program
	END		;program end

Note: MCU does not provide specific unstack and push instructions, so users need to protect interrupt scene.

Example: interrupt-in protection

Γ	PUSH:	<u> </u>		
		LD	ACC_BAK,A	;save ACC to ACC_BAK
		SWAPA	STATUS	;swap half-byte of STATUS
		LD	STATUS_BAK,A	;save to STATUS_BAK
		RET		;back

Example: interrupt-out restore

POP:			
	SWAPA	STATUS_BAK	;swap the half-byte data from STATUS_BAK to ACC
	LD	STATUS,A	;pass the value in ACC to STATUS
	SWAPR	ACC_BAK	;swap the half-byte data in ACC_BAK
	SWAPA	ACC_BAK	;swap the half-byte data from ACC_BAK to ACC
	RET		;back



2.1.1.3 Jump table

Jump table can achieve multi-address jump. Since the addition of PCL and ACC is the new value of PCL, multi-address jump is then achieved through adding different values of ACC to PCL. If the value of ACC is n, then PCL+ACC represents the current address plus n. After the execution of the current instructions, the value of PCL will add 1 (refer to the following examples). If PCL+ACC overflows, then PC will not carry. As such, user can achieve multi-address jump through setting different values of ACC.

PCLATH is the PC high bit buffer register. Before operating on PCL, value must be given to PCLATH.

Example: correct illustration of multi-address jump

OTP address				
	LDIA	01H		
	LD	PCLATH,A	;load value to PCLATH	
0110H:	ADDR	PCL	;ACC+PCL	
0111H:	JP	LOOP1	;ACC=0, jump to LOOP1	
0112H:	JP	LOOP2	;ACC=1, jump to LOOP2	
0113H:	JP	LOOP3	;ACC=2, jump to LOOP3	
0114H:	JP	LOOP4	;ACC=3, jump to LOOP4	
0115H:	JP	LOOP5	;ACC=4, jump to LOOP5	
0116H:	JP	LOOP6	;ACC=5, jump to LOOP6	

Example: wrong illustration of multi-address jump

OTP address	_	_	
	CLR	PCLATH	
00FCH:	ADDR	PCL	;ACC+PCL
00FDH:	JP	LOOP1	;ACC=0, jump to LOOP1
00FEH:	JP	LOOP2	;ACC=1, jump to LOOP2
00FFH:	JP	LOOP3	;ACC=2, jump to LOOP3
0100H:	JP	LOOP4	;ACC=3, jump to 0000H
0101H:	JP	LOOP5	;ACC=4, jump to 0001H
0102H:	JP	LOOP6	;ACC=5, jump to 0002H

Note: Since PCL overflow will not carry to the higher bits, the program cannot be placed at the partition of the OTP space when using PCL to achieve multi-address jump.



2.1.2 Data memory

SC8P054 data memory list

	Add.		Add.		Add.		Ac
INDF	00H	INDF	80H		100H		180
OPTION_REG	01H	TMR0	81H		101H		18
PCL	02H	PCL	82H		102H		18
STATUS	03H	STATUS	83H		103H		183
FSR	04H	FSR	84H		104H		18
TRISB	05H	TRISA	85H		105H		18
PORTB	06H	PORTA	86H		106H		180
WPDB	07H	WPDA	87H		107H		18
WPUB	08H	WPUA	88H		108H		188
IOCB	09H	IOCA	89H		109H		189
PCLATH	0AH	PCLATH	8AH		10AH		18
INTCON	0BH	INTCON	8BH		10BH		18
ODCONB	0CH	ODCONA	8CH		10CH		180
PIR1	0DH		8DH		10DH		181
PIE1	0EH		8EH		10EH		181
CMPCON0	0FH		8FH		10FH		181
CMPCON1	10H		90H		110H		190
PR2	11H		91H		111H		19
TMR2	12H		92H		112H		19:
T2CON	13H		93H		113H		193
OSCCON	14H		94H		114H		194
PWMCON0	15H		95H		115H		19
PWMCON1	16H		96H		116H		190
PWMTL	17H		97H		117H		19
PWMTH	18H		98H		118H		198
PWMD0L	19H		99H		119H		199
PWMD1L	1AH		9AH		11AH		19/
PWMD4L	1BH	PWMD2L	9BH		11BH		191
PWMT4L	1CH	PWMD3L	9CH		11CH		190
PWMCON2	1DH	PWM23DT	9DH		11DH		19[
PWMD01H	1EH	PWMD23H	9EH		11EH		191
PWM01DT	1FH		9FH		11FH		191
	20H		A0H		120H		1A
		Universal register 32-byte					
			BFH				
Universal register 96-byte							
			EFH		16FH		1E
			F0H		170H		1F
		Rapid storage area					
	7FH	70H-7FH	FFH		17FH		1F
BANK0		BANK1		BANK2		BANK3	

Data memory is divided into two functional areas: special function registers and general-purpose data memory. Most of the data memory cells are readable/writable, but some are read-only. Special function registers are addressed from 00H-1FH, 80-9FH.



SC8P054 special function register summary Bank0

Add.	Name	Bit7	Bit6	Bit5	Bit4		Bit3	Bit2	Bit1	Bit0	Reset value
00H	INDF	Addressing this unit will address data memory (not a physical register) using the contents of the FSR.						xxxxxxx			
01H	OPTION_R EG		INTEDG	T0CS	TOSE		PSA	PS2	PS1	PS0	-1111011
02H	PCL				Program co	ounte	er low byte				00000000
03H	STATUS	IRP	RP1	RP0	ТО		PD	Z	DC	С	00011xxx
04H	FSR			Inc	direct data me	mory	address po	inter			xxxxxxx
05H	TRISB	TRISB7	TRISB6	TRISB5	TRISB4		TRISB3	TRISB2	TRISB1	TRISB0	11111111
06H	PORTB	RB7	RB6	RB5	RB4		RB3	RB2	RB1	RB0	XXXXXXXX
07H	WPDB	WPDB7	WPDB6	WPDB5	WPDB4			WPDB2	WPDB1	WPDB0	0000-000
08H	WPUB	WPUB7	WPUB6	WPUB5	WPUB4	١	WPUB3	WPUB2	WPUB1	WPUB0	00000000
09H	IOCB	IOCB7	IOCB6	IOCB5	IOCB4		IOCB3	IOCB2	IOCB1	IOCB0	00000000
0AH	PCLATH							Write buffer for the	ne high 3 bits of the p	orogram counter	000
0BH	INTCON	GIE	PEIE	TOIE	INTE		RBIE	TOIF	INTF	RBIF	00000000
0CH	ODCONB	ODCONB7	ODCONB6	ODCONB5	ODCONB4			ODCONB2	ODCONB1	ODCONB0	0000-000
0DH	PIR1			CMPIF	PWMIF		RAIF		TMR2IF		000-0-
0EH	PIE1			CMPIE	PWMIE		RAIE		TMR2IE		000-0-
0FH	CMPCON0	CMPEN	CMPPS	CMPNS2	CMPNS1	С	MPNS0	CMPNV	CMPOUT	CMPOEN	00000000
10H	CMPCON1	CMPIM	AN_EN	RBIAS_H	RBIAS_L			LVDS	00000000		
11H	PR2				TIMER2	perio	d register				11111111
12H	TMR2				TIMER2 n	nodul	e register				00000000
13H	T2CON	CLK_SEL	TOUTPS3	TOUTPS2	TOUTPS1	I	TOUTPSO	TMR2ON	T2CKPS1	T2CKPS0	00000000
14H	OSCCON		IRCF2	IRCF1	IRCF0				SWDTEN		-1011-
15H	PWMCON0		CLKDIV<2:	0>	PWM4EN	J	PWM3EN	PWM2EN	PWM1EN	PWM0EN	00000000
16H	PWMCON1		PWM_IOSEL	PWM2DTEN	PWM0DTE	N			DT_DI	V<1:0>	-00000
17H	PWMTL				PWM0~PWM1 p	period I	ow 8-bit register				00000000
18H	PWMTH			PWM4I	D<9:8>		PWN	Л4T<9:8>	PWM	T<9:8>	000000
19H	PWMD0L		PWM0 duty cycle lower 8 bits						00000000		
1AH	PWMD1L	PWM1 duty cycle lower 8 bits						00000000			
1BH	PWMD4L		PWM4 duty cycle lower 8 bits						00000000		
1CH	PWMT4L				PWM4 period	low	8-bit registe	er			00000000
1DH	PWMCON2				PWM4DIR	P۱	WM3DIR	PWM2DIR	PWM1DIR	PWM0DIR	00000
1EH	PWMD01H			PWMD1	<9:8>				PWMD	0<9:8>	0000
1FH	PWM01DT						PWM01E	OT<5:0>			000000



SC8P054 special function register summary Bank1

Add.	Name	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Reset value	
80H	INDF	Ac	Addressing this unit will address data memory (not a physical register) using the contents of the FSR.								
81H	TMR0				TIMER0	data register				xxxxxxx	
82H	PCL				Program c	ounter low byte				00000000	
83H	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	00011xxx	
84H	FSR			In	direct data me	mory address po	ointer			XXXXXXX	
85H	TRISA			TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	111111	
86H	PORTA			RA5	RA4	RA3	RA2	RA1	RA0	XXXXXX	
87H	WPDA			WPDA5	WPDA4	WPDA3	WPDA2	WPDA1	WPDA0	000000	
88H	WPUA			WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	000000	
89H	IOCA			IOCA5	IOCA4	IOCA3	IOCA2	IOCA1	IOCA0	000000	
8AH	PCLATH						Write buffer for t	000			
8BH	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	00000000	
8CH	ODCONA			ODCONA5	ODCONA4	ODCONA3	ODCONA2	ODCONA1	ODCONA0	000000	
9BH	PWMD2L		PWM2 duty cycle lower 8 bits								
9CH	PWMD3L		PWM3 duty cycle lower 8 bits							00000000	
9DH	PWM23DT				PWM23 dead delay time						
9EH	PWMD23H			PWMD3	PWMD3<9:8> PWMD2<9:8>					0000	



2.2 Addressing mode

2.2.1 Direct addressing

It operates the RAM through the operation register (ACC).

Example: pass the value in ACC to 30H register

LD 30H,A

Example: pass the value in 30H register to ACC

LD A,30H

2.2.2 Immediate addressing

Pass the immediate value to accumulator (ACC)

Example: pass the immediate value 12H to ACC

LDIA 12H

2.2.3 Indirect addressing

Data memory can be addressed directly or indirectly. Direct addressing can be achieved through INDF register, and INDF is not a physical register. When INDF is accessed, it is addressed according to the value in the FSR register, and points to the register at that address. Therefore, after setting the FSR register, INDF register can be regarded as a target register. Read INDF (FSR=0) indirectly will produce 00H. Write to the INDF register indirectly will cause a null operation. The following example shows how indirect addressing works.

Example: application of FSR and INDF

LDIA	30H	
LD	FSR,A	;point to 30H for indirect addressing
CLR	INDF	;clear INDF, which means clearing the 30H address RAM that FSR points to

Example: clear RAM (20H-5FH) for indirect addressing

	LDIA	1FH	
	LD	FSR,A	;point to 1FH for indirect addressing
LOOP:			
	INCR	FSR	;address add 1, and initial address is 20H
	CLR	INDF	;clear the address where FSR points to
	LDIA	5FH	
	SUBA	FSR	
	SNZB	STATUS,C	;clear until the address of FSR is 5FH
	JP	LOOP	



2.3 Stack

Stack buffer of the chip has 8 levels. Stack buffer is not part of data memory nor program memory. It cannot be written nor read. Operation on the stack buffer is through the stack pointer (SP), which also cannot be written nor read. After the system is reset, the SP points to the top of the stack. When a subroutine call or interrupt occurs, values in the program counter (PC) will be transferred to the stack buffer. When return from interrupt or return from subroutine, values are transferred back to the PC. The following diagram illustrates how this works.

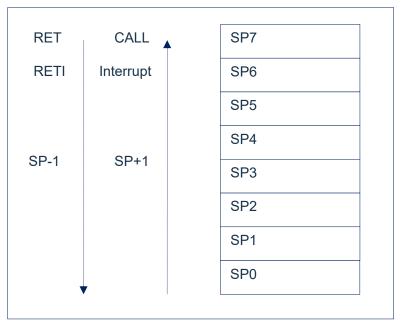


Figure 2-1: How the stack buffer works

Stack buffer will follow one principle: 'first in last out'.

Note: Stack buffer has only 8 levels, if the stack is full and an interrupt happens which is non-maskable, then only the flag bit of the interrupt will be logged. The response for the interrupt will be suppressed until the pointer of stack starts to decrease. This feature can prevent overflow of the stack caused by the interrupt. Similarly, when stack is full and subroutine happens, then stack will overflow and the contents which enter the stack first will be lost, only the last 8 return addresses will be saved. Therefore, users should pay attention to this point when writing programs to avoid program loops.



2.4 Accumulator (ACC)

2.4.1 Overview

ALU is an 8-bit arithmetic-logic unit. All math and logic related calculations in MCU are done by ALU. It can perform addition, subtraction, shift and logical calculation on data; ALU can also control STATUS to represent the status of the calculation result.

ACC register is an 8-bit register to store the ALU calculation result. It does not belong to data memory. It is in CPU and used by ALU during calculation. Hence it cannot be addressed. It can only be used through the provided instructions.

2.4.2ACC application

Example: use ACC for data transferring

LD	A,R01	;load the value in register R01 to ACC
LD	R02,A	;load the value in ACC to register R02

Example: use ACC for immediate addressing

LDIA	30H	;load 30H to ACC
ANDIA	30H	;perform 'AND' on ACC and 30H ;save the result to ACC
XORIA	30H	;perform 'XOR' on ACC and 30H ;save the result to ACC

Example: use ACC as the first operand of a dual operand instruction

HSUBA	R01	;ACC-R01, save the result to ACC
HSUBR	R01	;ACC-R01, save the result to R01

Example: use ACC as the second operand of a dual operand instruction

SUBA	R01	;R01-ACC, save the result to ACC
SUBR	R01	;R01-ACC, save the result to R01



2.5 Program status register (STATUS)

STATUS register includes:

- ◆ ALU arithmetic status
- Reset status

Just like other registers, STATUS register can be the target register of any instruction. If an instruction that affects Z, DC or C bit that use STATUS as target register, then it cannot write on these 3 status bits. These bits are cleared or set to 1 according to device logic. TO and PD bit also cannot be written. Hence the instructions which use STATUS as target instruction may not result in what is predicted.

For example, CLRSTATUS will clear higher 3 bits and set the Z bit to 1. Hence the value of STATUS will be 000u u1uu (u will not change). It is recommended to only use CLRB, SETB, SWAPA and SWAPR instructions to change STATUS register because these will not affect any status bits.

Program status register STATUS (03H)

•	•	`	,					
03H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	1	1	Х	Х	Х

Bit7 IRP Register memory select bit (indirect addressing)

1= Unused

0= Bank0 and Bank1 (00h~FFh)

Bit6~Bit5 RP[1:0] Memory select bit

00= Select Bank0 01= Select Bank1

10= Unused 10= Unused

Bit4 TO: Time out bit;

1= Power on or CLRWDT instruction or STOP instruction

0= WDT time out

Bit3 PD: Power down bit

1= Power on or CLRWDT instruction

= Execute STOP instruction

Bit2 Z: Result bit

I = The result of an arithmetic or logical operation is zero

0= The result of an arithmetic or logical operation is not zero

Bit1 DC: Half carry bit/borrow bit

1= Carry happens from the lower 4 bits to the higher bits, or no borrow from the lower 4 bits.

0= No carry from the lower 4 bits to the higher bits, or borrow from the lower 4 bits to the higher bits.

Bit0 C: Carry/borrow bit

1= A carry from the highest bit, or no borrow.

0= No carry from the highest bit, or a borrow hanppens.



TO and PD flag bits can reflect the reason for chip reset. The following lists the events that affect the TO and PD and the status of the TO and PD after various resets.

Events	TO	PD
Power on	1	1
WDT overflow	0	Χ
STOP instruction	1	0
CLRWDT instruction	1	1
Sleep	1	0

Table of	of events	affecting	PD	and	TO
----------	-----------	-----------	----	-----	----

TO	PD	Reset reason
0	0	Sleep state WDT overflow
0	1	Non-sleep state WDT overflow
1	1	Power on

Status of TO/PD after reset



2.6 Pre-scaler (OPTION_REG)

OPTION_REG register is a readable/writable register that contains various control bits for configuration.

- ♦ WDT pre-scaler
- ◆ External interrupt trigger edge

Prescaler control register OPTION REG (01H)

01H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
OPTION_REG		INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0
R/W		R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value		1	1	1	1	0	1	1

Bit7	Unused	
Bit6	INTEDG:	Trigger interrupt edge selection bit
	1=	INT pin rising edge trigger interrupt.
	0=	INT pin falling edge trigger interrupt.
Bit5	T0CS:	TIMER0 clock source select bit
	0=	Internal instruction period clock (Fcpu)
	1=	Transition edge on the T0CKI pin
Bit4	T0SE:	TIMER0 clock source edge select bit
	0=	Increase when T0CKI pin signal transited from low to high
	1=	Increase when T0CKI pin signal transited from high to low
Bit3	PSA:	Pre-scaler allocation bit
	0=	Allocate pre-scaler to TIMER0 module
	1=	Allocate pre-scaler to WDT
Di+O	Deal Deal	Dra allocation parameter configure hit

Bit2~Bit0 PS2~PS0: Pre-allocation parameter configure bit

PS1	PS0	TMR0 frequency division ratio	WDT frequency division ratio
0	0	1:2	1:1
0	1	1:4	1:2
1	0	1:8	1:4
1	1	1:16	1:8
0	0	1:32	1:16
0	1	1:64	1:32
1	0	1:128	1:64
1	1	1:256	1:128
	0 0 1 1	0 0 0 1 1 1 0 1 1 0 0 0 0 1	0 0 1:2 0 1 1:4 1 0 1:8 1 1 1 1:16 0 0 1:32 0 1 1:64 1 0 1:128

The pre-scaler register is an 8-bit counter. When surveil on register WDT, it is a postscaler; when it is used as a timer or counter, it is called pre-scaler. There is only 1 physical scaler and can only be used for WDT or TIMER0, but not at the same time. This means that if it is used for TIMER0, the WDT cannot use pre-scaler and vice versa.

When used for WDT, the CLRWDT instruction will clear pre-scaler and WDT timer.

When used for TIMER0, all instructions related to writing to TIMER0 (such as: CLR TMR0, SETB TMR0,1) will clear the pre-scaler.



2.7 Program counter (PC)

Program counter (PC) controls the instruction sequence in program memory OTP, it can address in the whole range of OTP. After obtaining the instruction code, PC will increase by 1 and point to the address of the next instruction code. When executing jump, condition jump, loading value to PCL, subroutine call, initializing reset, interrupt, interrupt return, subroutine return and other actions, PC will load the address which is related to the instruction, rather than the address of the next instruction.

When encountering a condition jump instruction and the condition is met, the next instruction to be read during current instruction execution will be discarded and an empty instruction period will be inserted. After this, the correct instruction can be obtained. If not, the next instruction is executed in sequence.

Program counter (PC) is 11-bit width, users can access lower 8 bits by PCL (02H). The higher 3 bits cannot be accessed. It can hold address for 2K×16Bit program. Loading a value to PCL results in a short jump to the 256 addresses of the current page.

Note: When the programmer uses PCL to make a short jump, the programmer must first load a value to the PC high bit buffer register PCLATH.

The PC values for several special cases are given below

Reset	PC=0000;			
Interrupt	PC=0004 (original PC+1 will be add to stack automatically);			
CALL	PC=Program specified address (original PC+1 will be add to stack automatically);			
RET, RETI, RETI	PC=Value from stack;			
PCL operation	PC[10:8] unchanged, PC[7:0]=user defined value;			
JP	PC=Program specified value;			
Other instructions	PC=PC+1;			



2.8 Watchdog timer (WDT)

Watch Dog Timer (WDT) is an on-chip self-oscillating RC oscillator timer, without any peripheral components. Even if the chip's main clock stops working, the WDT can also keep time. WDT overflow will generate a reset.

2.8.1 WDT period

WDT and TIMER0 share the same 8-bit prescaler. After all resets, the WDT overflow period is 128ms, if you need to change the WDT period, you can set the OPTION_REG register. The overflow period of the WDT will be affected by the ambient temperature, the supply voltage and other parameters.

The "CLRWDT" and "STOP" instructions clear the WDT timer and the count value in the prescaler (when the prescaler is assigned to the WDT). WDT generally is used to prevent the system and MCU program from being out of control. Under normal circumstances, the WDT should be cleared by the "CLRWDT" instruction before it overflows to prevent a reset. If program is out of control for some reason such that "CLRWDT" instruction is not able to execute before overflow, WDT overflow will then generate a reset to make sure the system restarts. If a reset is generated by the WDT overflow, then 'TO' bit of STATUS will be cleared to 0. Users can judge whether the reset is caused by WDT overflow according to this.

Note:

- If WDT is used, 'CLRWDT' instruction must be placed somewhere is the program to make sure
 it is cleared before WDT overflow. If not, chip will keep resetting and the system cannot be
 operated normally.
- 2. It is not allowed to clear WDT during interrupt so that the main program 'run away' can be detected.
- 3. The program should have one WDT clearing operation in the main program, and try not to clear the WDT in multiple branches, this architecture can maximize the protection function of the watchdog counter.
- 4. The overflow time of the watchdog counter varies from chip to chip, so when setting the clear WDT time, there should be a greater redundancy with the WDT overflow time to avoid an unnecessary WDT reset.



2.8.2 Registers related to watchdog control

Oscillation control register OSCCON (14H)

14H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
OSCCON		IRCF2	IRCF1	IRCF0			SWDTEN	
R/W		R/W	R/W	R/W			R/W	
Reset value		1	0	1			1	

Bit7 Unused

Bit6~Bit4 IRCF<2:0>: Internal oscillator frequency selection bit;

111= F_{SYS} = F_{HSI}/1

110= Fsys = Fhsi/2

101= $F_{SYS} = F_{HSI}/4$ (default)

100= Fsys = Fhsi/8

011= F_{SYS} = F_{HSI}/16

010= $F_{SYS} = F_{HSI}/32$

 $001 = F_{SYS} = F_{HSI}/64$

000= $F_{SYS} = 32KHz(F_{LSI})$

Bit3~Bit2 Unused

Bit1 SWDTEN: Software enable or disable watchdog timer bit

1= Enable WDT

0= Disable WDT

Bit0 Unused

Note: If the WDT configuration bit in CONFIG = 1, WDT is always enabled, regardless of the state of the SWDTEN control bit. If the WDT configuration bit in CONFIG = 0, the SWDTEN control bit can be used to enable or disable WDT.



3. System Clock

3.1 Overview

The clock signals are generated by an oscillator, which generates 4 non-overlapping quadrature clock signals, called Q1, Q2, Q3, and Q4. Each Q1 inside the IC increments the program counter (PC) by one, and Q4 removes the instruction from the program memory cell and locks it into the instruction register. The removed instruction is decoded and executed between the next Q1 and Q4, which means that it takes 4 clock cycles to execute an instruction. The following figure represents the clock versus instruction cycle execution timing diagram.

An instruction cycle contains four Q-cycles, and the instruction execution and fetching are in pipeline structure, fetching finger occupies one instruction cycle, while decoding and execution occupy another instruction cycle, but due to the pipeline structure, from a macro point of view, the effective execution time of each instruction is one instruction cycle. If an instruction causes the program counter address to change (e.g. JP) then the prefetched instruction opcode is invalid and it takes two instruction cycles to complete the instruction, which is the reason why all instructions operating on the PC take up two clock cycles.

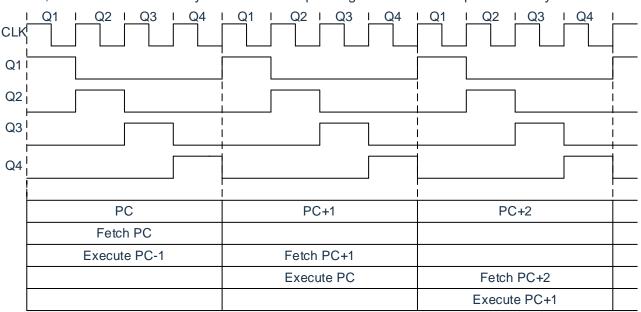


Figure 3-1: Clock and instruction cycle timing chart (F_{CPU} DIV=4T)

Following is the relationship between working frequency of system and the speed of instructions when F_{CPU} DIV=4T:

System frequency (F _{SYS})	Dual instruction period	Single instruction period
1MHz	8µs	4µs
2MHz	4µs	2µs
4MHz	2µs	1µs
8MHz	1µs	500ns
16MHz	500ns	250ns



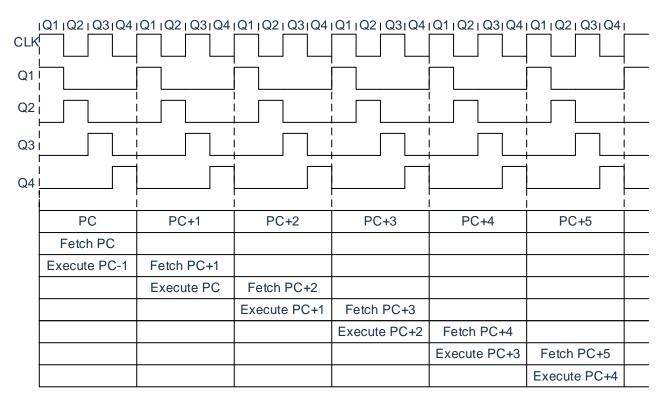


Figure 3-2: Clock and instruction cycle timing chart (F_{CPU}_DIV=2T)

Following is the relationship between working frequency of system and the speed of instructions when F_{CPU} DIV=2T:

System frequency (Fsys)	Dual instruction period	Single instruction period
1MHz	4µs	2µs
2MHz	2µs	1µs
4MHz	1µs	500ns
8MHz	500ns	250ns
16MHz	250ns	125ns



3.2 System oscillator

The chip has one type of oscillation: internal RC oscillation.

3.2.1 Internal RC oscillation

The default oscillation mode of the chip is internal RC oscillation, and the oscillation frequency is fixed at 16MHz. On this basis, the operating frequency of the chip can be set through the OSCCON register.

3.3 Reset time

Reset Time is the time from the chip reset to the chip oscillation stabilization, its design value is about 16ms.

Note: Reset time exists for both power on reset and other resets.

3.4 Oscillator control register

Oscillator Control (OSCCON) register controls the system clock and frequency selection.

Oscillator control register OSCCON (14FH)

14H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
OSCCON		IRCF2	IRCF1	IRCF0			SWDTEN	
R/W		R/W	R/W	R/W			R/W	
Reset value		1	0	1			1	

Bit7	Unused	
Bit6~Bit4	IRCF<2:0>:	Internal oscillator frequency selection bit
	111=	Fsys = F _{HSI} /1
	110=	$F_{SYS} = F_{HSI}/2$
	101=	Fsys = F _{HSI} /4 (default)
	100=	Fsys = Fhsi/8
	011=	Fsys = F _{HSI} /16
	010=	Fsys = F _{HSI} /32
	001=	Fsys = Fhsi/64
	000=	F _{SYS} = 32KHz(LFINTOSC)
Bit3~Bit2	Unused	
Bit1	SWDTEN:	Software enable or disable watchdog timer bit
	1=	Enable WDT
	0=	Disable WDT
Bit0	Unused	



3.5 Clock block diagram

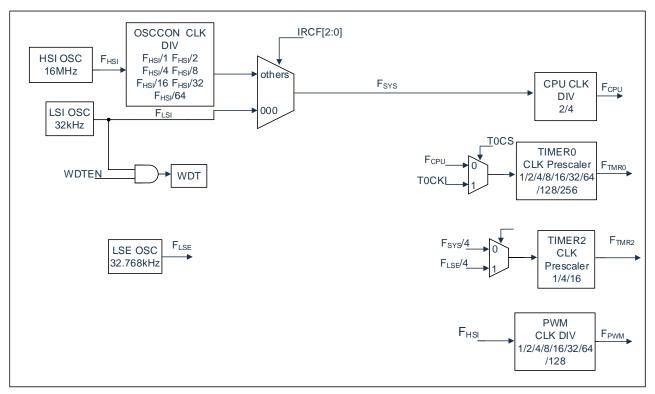


Figure 3-3: Clock block diagram



4. Reset

The chip can be reset in the following three ways:

- Power on reset
- Low voltage reset
- Watchdog overflow reset during normal operation

When any of the above reset occurs, all system registers will be restored to their default state, the program will stop running, and the program counter (PC) will be cleared to zero. At the same time, the program will start running from reset vector 0000H after the reset. The TO and PD flags of STATUS can give information about the reset state of the system (see the description of STATUS for details), and the user can control the program execution path according to the state of PD and TO.

Any kind of reset situation requires a certain response time, and the system provides a completed reset process to ensure that the reset action is carried out smoothly.

4.1 Power on reset

Power-on reset is closely related to LVR operation. The process of system power-on is in the form of a gradually rising curve and takes some time to reach the normal level value. The normal timing of the power-on reset is given below:

- Power-on: the system detects a rise in the supply voltage and waits for it to stabilize.
- System initialization: all system registers are set to their initial values.
- Oscillator start: the oscillator starts to supply the system clock.
- Program execution: the power-on ends and the program start to run.



4.2 Power off reset

4.2.1 Overview

Power off reset is used for voltage drop caused by external factors (such as interference or change in external load). Voltage drop may enter system dead zone. System dead zone means power source cannot satisfy the minimal working voltage of the system.

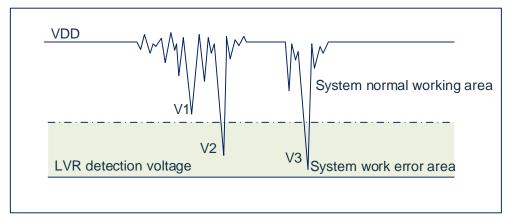


Figure 4-1: Power off reset

The diagram above is a typical power-off reset case. In the diagram, VDD is severely disturbed and the voltage value drops to a very low value. The system works normally in the area above the dotted line; in the area below the dotted line, the system enters an unknown operating state, and this area is called the dead zone. When VDD drops to V1, the system is still in the normal state; when VDD drops to V2 and V3, the system enters the dead zone, and it is easy to cause errors.

The system may enter a dead zone in the following cases:

- In DC applications:
- Battery power is generally used in DC applications. When the battery voltage is too low or when the microcontroller drives the load, the system voltage may drop and enter the dead zone. At this time, the power supply will not drop further to the LVD detection voltage, so the system is maintained in the dead zone.
- In AC application:
- When the system is powered by AC, the DC voltage value is affected by the noise in the AC power supply. When the external is over-loaded, such as when driving a motor, the interference generated by the load action also affects the DC power supply. if the VDD drops below the minimum operating voltage due to the interference, the system will likely enter an unstable operation state.
- In AC application, the system has a long power up and down time. Among them, the power-on timing protection makes the system power up normally, but the power-off process is similar to the situation in DC applications, where the VDD voltage tends to enter the dead zone during the slow drop after the AC power is turned off.



As shown above, the system normal operating voltage is generally higher than the system reset voltage, while the reset voltage is determined by the low voltage detection (LVR) level. When the system execution speed increases, the system minimum operating voltage also increases accordingly. However, as the system reset voltage is fixed, there will be a voltage region between the system minimum operating voltage and the system reset voltage where the system cannot work normally and will not reset. This area is known as the dead zone.



4.2.2Improvements for power off reset

Several suggestions to improve the system power-off reset performance:

- ◆ Select a higher LVR voltage, which contributes to a more reliable reset.
- ◆ Turn on the watchdog timer.
- Reduce the operating frequency of the system.
- Increase the voltage drop slope.

Watchdog timer

The watchdog timer is used to ensure the normal operation of the program. When the system enters the dead zone or the program runs with errors, the watchdog timer will overflow and the system will be reset.

Reduce the operating speed of the system

The faster the operating frequency of the system, the higher the minimum operating voltage of the system. Therefore, by increasing the range of the operating dead zone and reducing the operating speed of the system, the minimum operating voltage can be reduced and the chance of entering the dead zone can be effectively reduced.

Increase the voltage drop slope

This method is used under AC. Voltage drops slowly under AC and cause the system to stay longer at the dead zone. If the system is power on at this moment, error may happen. It is then suggested to insert a resistor between power source and ground to ensure the MCU pass the dead zone and enter the reset zone faster.



4.3 Watchdog reset

The watchdog reset is a protect configuration for the system. In the normal state, the watchdog timer is cleared to zero by the program. If something goes wrong, the system is in an unknown state and the watchdog timer overflows, at which point the system resets. After the watchdog reset, the system reboots into the normal state.

The timing of the watchdog reset is as follows:

- Watchdog timer status: the system detects whether the watchdog timer overflows, and if it does, the system resets.
- Initialization: all system registers are set to their default state.
- Oscillator start: the oscillator starts to provide the system clock.
- Program: the reset ends and the program starts running.

For application of watchdog timer, please refer to Section 2.8.



5. Sleep Mode

5.1 Enter sleep mode

System can enter sleep mode when executing STOP instructions. If WDT enabled, then:

- WDT is cleared and continue to run.
- ◆ PD bit of the STATUS register is cleared.
- ◆ TO bit set to 1.
- Turn off the oscillator driver.
- I/O port keep at the status before STOP (driver is high level, low level, or high impedance).

In sleep mode, to avoid current consumption, all I/O pins should keep at VDD or GND to make sure no external circuit is consuming the current from I/O pins. To avoid input pin, float and invoke current, high impedance I/O should be pulled to high or low level externally. Internal pull up resistance should also be considered.

5.2 Wake up from sleep mode

The device can be woken from sleep by any of the following events.

- 1. Watchdog timer wakeup;
- 2. PORTA interrupt on change;
- 3. PORTB interrupt on change or peripheral interrupt.

The two events described above are considered to be a continuation of program execution. The TO and PD bits in the STATUS register are used to determine the cause of device reset. The PD bit is set to 1 at power-on and cleared when the STOP instruction is executed. The TO bit is cleared when a WDT awaken occurs.

When the STOP instruction is executed, the next instruction (PC+1) is taken out in advance. If it is desired to awaken the device by an interrupt event, the corresponding interrupt enable bit must be set to 1 (enable). The awaken is not related to the GIE bit. If the GIE bit is cleared (disable), the device will continue to execute the instruction after the STOP instruction. If the GIE bit is set to 1 (enable), the device executes the instruction after the STOP instruction and then jumps to the interrupt address (0004h) to execute the code. If you do not want to execute the instruction after the STOP instruction, the user should set a NOP instruction after the STOP instruction. The WDT will all be cleared when the device awakens from sleep mode, regardless of the reason for awakening.



5.3 Interrupt wakeup

When the global interrupt is disabled (GIE is cleared) and there exist 1 interrupt source with its interrupt enable bit and flag bit set to 1, one event from the following will happen:

- If an interrupt is generated before the STOP instruction is executed, then the STOP instruction will be executed as a NOP instruction. Therefore, WDT and its pre-scaler and post-scaler (if enabled) will not be cleared. At the same time, the TO bit will not be set to 1 and the PD will not be cleared.
- If an interrupt is generated during or after the execution of the STOP instruction, the device will be immediately awakened from sleep mode. The STOP instruction will be executed before the wake-up. Therefore, the WDT and its pre-scaler and post-scaler (if enabled) will be cleared to zero and the TO bit will be set to 1, while the PD will also be cleared to zero. Even if the flag bit is checked to be 0 before the STOP instruction is executed, it may be set to 1 before the STOP instruction is completed. To determine if the STOP instruction is executed, the PD bit can be tested. If the PD bit is set to 1, then the STOP instruction is executed as a NOP instruction. Before executing the STOP instruction, a CLRWDT instruction must be executed to ensure that the WDT is cleared to zero.



5.4 Sleep mode application

Before the system enters the sleep mode, if the user needs to get a smaller sleep current, please confirm the status of all I/O ports, if there are floating I/O ports in the user's program, set all floating ports as output ports to make sure that each input port has a fixed state to avoid that when the I/O is an input state, the port level is in an unstable state which increases the sleep current; turn off the other peripheral modules, such as the AD module. According to the actual functional requirements of the program, the WDT function can be disabled to reduce the sleep current.

Example: procedures for entering sleep mode

Example: procedures	ior ornorning orox	op mode	
SLEEP_MODE:			
	CLR	INTCON	;Disable interrupts
	LDIA	B'00000000'	
	LD	TRISB,A	;All I/Os set as output ports
			;Disable other functions
	LDIA	0A5H	
	LD	SP_FLAG,A	;Set sleep status memory register (user-
	CLRWDT		;Clear WDT
	STOP		;Execute STOP instruction
	NOP		
	NOP		

5.5 Sleep mode wake-up time

When the MCU is woken up from sleep, it needs to wait for an oscillation stabilization time (Reset Time). The relationship is shown in the following table.

System r	main clock so	urce		System clock frequency (IRCF<2:0>)	Sleep wakeup wait time T _{WAIT}	
				F _{SYS} =F _{HSI}	Twait=136*1/F _{HSI} +16*1/F _{HSI}	
Internal	high-speed	RC	oscillation	F _{SYS} = F _{HSI} /2	T _{WAIT} =136*2/F _{HSI} +16*1/F _{HSI}	
(F _{HSI})						
				Fsys= F _{HSI} /64	Twait=136*64/F _{HSI} +16*1/F _{HSI}	
Internal	low-speed	RC	oscillation		T 44/5	
(FLFINTOS	c)				T _{WAIT} =11/F _{LSI}	



6. I/O Ports

The chip has two I/O ports: PORTA, PORTB (up to 14 I/Os). These ports can be accessed directly from the read/write port data registers.

Port	Bit	Din description	I/O					
FOIL		Pin description						
	0	Schmitt trigger input, configurable as push-pull or open-drain outputs	I/O					
	1	Schmitt trigger input, configurable as push-pull or open-drain outputs	I/O					
	2	Schmitt trigger input, configurable as push-pull or open-drain outputs, PWM2 output	I/O					
PORTA	3	output						
	4	Schmitt trigger input, configurable as push-pull or open-drain outputs	I/O					
	5	Schmitt trigger input, configurable as push-pull or open-drain outputs, PWMC0 output	I/O					
	0	Schmitt trigger input, configurable as push-pull or open-drain outputs, PWM0 output, CMP output, external interrupt input	1/0					
	1	Schmitt trigger input, configurable as push-pull or open-drain outputs, PWM1 output, CMP positive or negative input	I/O					
	2	Schmitt trigger input, configurable as push-pull or open-drain outputs, PWM4 output, CMP negative input	I/O					
	3	Schmitt trigger input, open-drain output, Programming high-voltage input	I/O					
PORTB	4	Schmitt trigger input, configurable as push-pull or open-drain outputs, programming clock input, CMP negative input, PWMC4 output	I/O					
	5	Schmitt trigger input, configurable as push-pull or open-drain outputs, programming data input/output, CMP negative input, PWMC3 output	I/O					
	6	Schmitt trigger input, configurable as push-pull or open-drain outputs, PWMC2 output	I/O					
	7	Schmitt trigger input, configurable as push-pull or open-drain outputs, PWMC1 output	I/O					

<Table 6-1: Port configuration overview>



6.1 I/O port structure

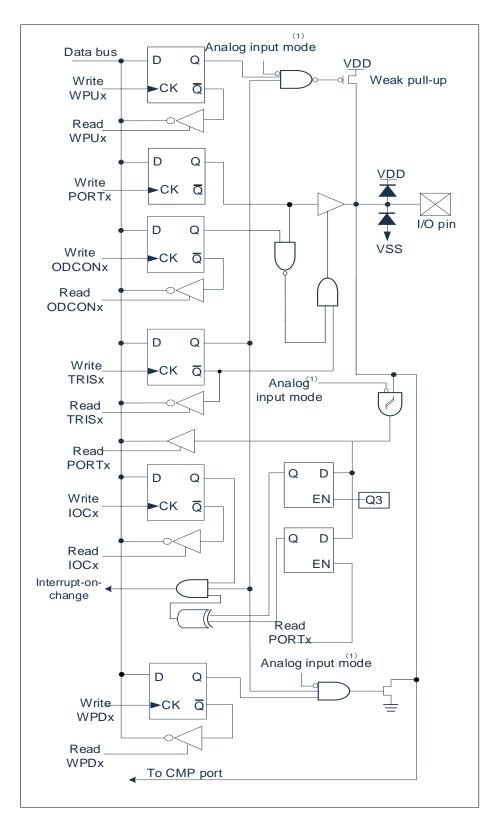


Figure 6-1: I/O port stucture

Note: AN_EN determines the analog input mode.



6.2 PORTA

6.2.1 PORTA data and direction

PORTA is a 6-bit bi-directional port. Its corresponding data direction register is TRISA. Setting one bit of TRISA to 1 (=1) can configure the corresponding pin to be input. Setting one bit of TRISA to 0 (=0) can configure the corresponding PORTA pin to be output.

Reading the PORTA register reads the state of the pin while writing the register will write to the port latch. All write operation procedure is reading-modifying-writing. Therefore, writing a port means reading the pin level of that port at first, then modifying the read value, and finally writing the modified value to the port data latch. Even when the PORTA pin is used as an analog input, the TRISA register still controls the direction of the PORTA pin. When using the PORTA pin as an analog input, the user must ensure that the bit in the TRISA register remains as 1. I/O pins configured as analog inputs always read 0.

The registers related to the PORTA port are PORTA, TRISA, WPUA, WPDA, ODCONA, IOCA and so on. PORTA data register PORTA(86H)

86H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PORTA			RA5	RA4	RA3	RA2	RA1	RA0
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			Χ	Χ	Χ	Х	Χ	Х

Bit7~Bit6 Unused

Bit5~Bit0 PORTA<5:0>: PORTAI/O pin bit

1= Port pin level>V_{IH} 0= Port pin level<V_{IL}

PORTA direction register TRISA(85H)

85H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
TRISA			TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			1	1	1	1	1	1

Bit7~Bit6 Unused

Bit5~Bit0 TRISA<5:0>: PORTA tristate control bit

1= PORTA pin set to be input (tristate)

0= PORTA pin set to be output

Example: PORTA procedure

LDIA	B'00110000'	;set PORTA<3:0> as output port, PORTA<5:4>as input port
LD	TRISA,A	
LDIA	03H	;PORTA<1:0>output high level, PORTA<3:2>output low level
LD	PORTA,A	;since PORTA<5:4> is an input port, loading 0 or 1 has no effect.



6.2.2 PORTA open-drain output control

Each PORTA pin has individually configurable open-drain output enable control bits.

PORTA open-drain output enable register ODCONA(8CH)

8CH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
ODCONA			ODCONA5	ODCONA4	ODCONA3	ODCONA2	ODCONA1	ODCONA0
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			0	0	0	0	0	0

Bit7~Bit6 Unused

Bit5~Bit0 ODCONA<5:0>: PORTA open-drain output enable

1= Enable open-drain output0= Disable open-drain output

6.2.3 PORTA pull-up resistor

Each PORTA pin has an individually configurable internal weak pull-up. Control bits WPUA<5:0> enable or disable each weak pull-up. When a port pin is configured as an output, its weak pull-up is automatically cut off.

PORTA pull-up resistor register WPUA(88H)

88H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
WPUA			WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			0	0	0	0	0	0

Bit7~Bit6 Unused

Bit5~Bit0 WPUA<5:0>: Weak pull-up register bit

1= Enable pull-up0= Disable pull-up

Note: If the pin is configured as an output, a weak pull up will be automatically disabled.



6.2.4PORTA pull-down resistor

Each PORTA pin has an internal weak pull-down that can be individually configured. The control bits WPDA<5:0> enable or disable each weak pull down. When a port pin is configured as an output, its weak pull-down is automatically cut off.

PORTA pull-down resistor register WPDA(87H)

87H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
WPDA			WPDA5	WPDA4	WPDA3	WPDA2	WPDA1	WPDA0
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			0	0	0	0	0	0

Bit7~Bit6 Unused

Bit6~Bit0 WPDA<5:0>: Weak pull-down register bit

1= Enable pull-down0= Disable pull-down

Note: If pin is configured as output, weak pull-down will be automatically disabled.

6.2.5 PORTA interrupt on change

All PORTA pins can be individually configured as interrupt on change pins. The control bit IOCA<5:0> enables or disables the interrupt function of each pin. Disable pin level change interrupt function when power on reset.

For the pin that has allowed level change interrupt, compare the value on the pin with the old value latched when PORTA was read last time. Perform a logical OR operation with the output "mismatch" of the last read operation to set the PORTA level change interrupt flag (RAIF) of the PIR1 register as 1.

This interrupt can wake up the device from sleep mode, and the user can clear the interrupt in the interrupt service program by the following ways:

- Read from or write to PORTA. This will end the mismatch state of the pin level.
- Clear the flag bit RAIF.

The mismatch status will continuously set the RAIF flag bit as 1. Reading or writing PORTA will end the mismatch state and allow the RAIF flag to be cleared.

Note: If the level of the I/O pin changes during the read operation (beginning of the Q2 cycle), the RAIF interrupt flag bit will not be set as 1. In addition, since reading or writing to a port affects all bits of the port, special care must be taken when using multiple pins in interrupt-on-change mode. When dealing with the level change of one pin, you may not notice the level change on the other pin.



PORTA interrupt-on-change register IOCA(89H)

89H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
IOCA			IOCA5	IOCA4	IOCA3	IOCA2	IOCA1	IOCA0
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			0	0	0	0	0	0

Bit7~Bit6 Unused

Bit5~Bit0 IOCA<5:0> PORTA interrupt-on-change control bit.

1= Enable interrupt-on-change.0= Disable interrupt-on-change.



6.3 PORTB

6.3.1 PORTB data and direction

PORTB is a 7-bit wide bi-directional port. The corresponding data direction register is TRISB. Setting one bit of TRISB to 1 (=1) can configure the corresponding PORTB pin to be input. Setting one bit of TRISB to 0 (=0) can configure the corresponding PORTB pin to be output.

Reading the PORTB register reads the pin status and writing to the register will write the port latch. All write operations are read-modify-write operations. Therefore, writing a port means to read the pin level of the port first, modify the read value, and then write the modified value into the port data latch. Even when the PORTB pin is used as an analog input, the TRISB register still controls the direction of the PORTB pin. When using the PORTB pin as an analog input, the user must ensure that the bits in the TRISB register remain set as 1. I/O pin is always read 0 when configured as analog input.

The registers related to the PORTB port are PORTB, TRISB, WPUB, WPDB, IOCB, ODCONB and so on. PORTB data register PORTB(06H)

Reset value	Х	Х	Х	Х	Х	Х	Х	Х
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0
06H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0

Bit7~Bit0 PORTB<7:0>: PORTBI/O pin bit

1= Port pin level> V_{IH} 0= Port pin level< V_{IL}

Note: The RB3 port is fixed as an open-drain output, and can only output low level or high resistance state.

PORTB direction register TRISB (05H)

05H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	1	1	1	1	1	1	1	1

Bit7~Bit0 TRISB<7:0>: PORTB tristate control bit

1= PORTB pin configured as input(tristate)0= PORTB pin configured as output

Example: PORTB procedure

CLR	PORTB	;clear data register
LDIA	B'00110000'	;set PORTB<5:4> as input port, others as output port
LD	TRISB,A	



6.3.2PORTB open-drain output control

Each PORTB pin has individually configurable open-drain output enable control bits (except RB3).

PORTB open drain output enable register ODCONB(0CH)

0CH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
ODCONB	ODCONB7	ODCONB6	ODCONB5	ODCONB4		ODCONB2	ODCONB1	ODCONB0
R/W	R/W	R/W	R/W	R/W		R/W	R/W	R/W
Reset value	0	0	0	0		0	0	0

Bit7~Bit4 ODCONB<7:4>: PORTB open-drain output enable

1= Enable open-drain output

0= Disable open-drain output

Bit3 Unused

Bit2~Bit0 ODCONB<2:0>: PORTB open-drain output enable

1= Enable open-drain output0= Disable open-drain output

Note: The RB3 port is fixed as an open-drain output, and can only output low level or high resistance state.

6.3.3 PORTB pull-up resistor

Each PORTB pin has an internal weak pull up that can be individually configured. The control bits WPUB<7:0> enable or disable each weak pull up. When a port pin is configured as an output, its weak pull-up is automatically cut off.

PORTB pull-up resistor register WPUB(08H)

08H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
WPUB	WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	0	0	0	0	0

Bit7~Bit0 WPUB<7:0>: PORTB weak pull-up enable bit

1= Enable pull-up0= Disable pull-up

Note: When RB0~RB2, RB4~RB7 pins are configured as outputs or analog inputs, the weak pull-ups will be disabled automatically.

When RB3 is configured as an output, its weak pull-up will not be disabled.



6.3.4PORTB pull-down resistor

Each PORTB pin has an individually configurable internal weak pull-down (except RB3). Control bits WPDB<7:0> enable or disable each weak pull-down. When a port pin is configured as an output, its weak pull-down is automatically cut off.

PORTB pull-down resistor register WPDB(07H)

07H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
WPDB	WPDB7	WPDB6	WPDB5	WPDB4		WPDB2	WPDB1	WPDB0
R/W	R/W	R/W	R/W	R/W		R/W	R/W	R/W
Reset value	0	0	0	0		0	0	0

Bit7~Bit4 WPDB<7:4>: PORTB weak pull-down enable bit

1= Enable pull-down

0= Disable pull-down

Bit3 Unused

Bit2~Bit0 WPDB<2:0>: PORTB weak pull-down enable bit

1= Enable pull-down0= Disable pull-down

Note: RB0~RB2, RB4~RB7 pins are configured as outputs or analog inputs, the weak pull-down is automatically disabled.

There is no weak pull-down on pin RB3.

6.3.5 PORTB interrupt on change

All PORTB pins can be individually configured as interrupt on change pins. The control bit IOCB<7:0> allows or disables the interrupt function of each pin. Disable pin level change interrupt function when power on reset.

For the pin that has allowed interrupt on change, compare the value on the pin with the old value latched when PORTB was read last time. Perform a logical OR operation with the output "mismatch" of the last read operation to set the PORTB level change interrupt flag (RBIF) in the INTCON register as 1.

This interrupt can wake up the device from sleep mode, and the user can clear the interrupt in the interrupt service program in the following ways:

- Read or write to PORTB. This will end the mismatch state of the pin level.
- Clear the flag bit RBIF.

The mismatch status will continuously set the RBIF flag bit as 1. Reading or writing PORTB will end the mismatch state and allow the RBIF flag to be cleared. The latch will keep the last read value from the under voltage reset. After reset, if the mismatch still exists, the RBIF flag will continue to be set as 1.

Note: If the level of the I/O pin changes during the read operation (beginning of the Q2 cycle), the RBIF interrupt flag bit will not be set as 1. In addition, since reading or writing to a port affects all bits of the port, special care must be taken when using multiple pins in interrupt-on-change mode. When dealing with the level change of one pin, you may not notice the level change on the other pin.



PORTB interrupt-on-change register IOCB(09H)

09H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
IOCB	IOCB7	IOCB6	IOCB5	IOCB4	IOCB3	IOCB2	IOCB1	IOCB0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	0	0	0	0	0

Bit7~Bit0 IOCB<7:0> PORTB interrupt-on-change control bit.

1= Enabele interrupt-on-change.0= Disable interrupt-on-change.



6.4 I/O usage

6.4.1 Write to I/O port

The chip's I/O port register, like the universal register, can be written through data transfer instructions, bit manipulation instructions, etc.

Example: write to I/O port program

LD	PORTB,A	;load ACC to PORTB
CLRB	PORTB,1	;clear PORTB.1
SET	PORTB	;set all output ports of PORTB to 1
SETB	PORTB,1	;set PORTB.1 to 1

6.4.2Read from I/O port

Example: read from I/O port program

LD	A,PORTB	;load PORTB to ACC
SNZB	PORTB,1	;check if PORTB,1 is 1, if it is 1, skip the next statement
SZB	PORTB,1	;check if PORTB,1 is 0, if it is 0, skip the next statement

Note: When the user reads the status of an I/O port, if the I/O port is an input port, the data read back by the user will be the state of the external level of the port line. If the I/O port is an output port then the read value will be the data of the internal output register of this port.



6.5 Cautions on I/O port usage

When operating the I/O port, pay attention to the following aspects:

- 1. When I/O is converted from output to input, it is necessary to wait for several instruction periods for the I/O port to stabilize.
- 2. If the internal pull up resistor is used, when the I/O is converted from output to input, the stable time of the internal level is related to the capacitance connected to the I/O port. The user should set the waiting time according to the actual situation. Prevent the I/O port from scanning the level by mistake.
- 3. When the I/O port is an input port, its input level should be between "VDD+0.3V" and "GND-0.3V". If the input port voltage is not within this range, the method shown in the figure below can be used.

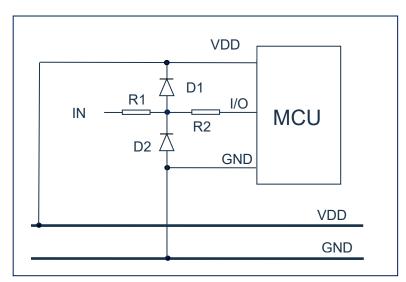


Figure 6-2: I/O port caution connection diagram

4. If long wires are connected to the I/O ports, add current limiting resistors near the I/O ports of the chip to enhance the MCU's EMC resistance.

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7. Interrupt

7.1 Overview

The chip has the following interrupt sources:

- PORTA interrupt on change;
 - TIMER0 overflow interrupt;
- PWM interrupt;
- ◆ CMP interrupt;

- PORTB interrupt on change;
- ◆ TIMER2 match interrupt;
- INT interrupt;

The interrupt control register (INTCON) and the peripheral interrupt request register (PIR1) record various interrupt requests in their respective flag bits. The INTCON register also contains the individual interrupt enable bits and the global interrupt enable bits.

The global interrupt enables bit GIE (INTCON<7>) allows all unmasked interrupts when set to 1, and prohibits all interrupts when cleared. Each interrupt can be prohibited through the corresponding enable bits in the INTCON and PIE1 registers. GIE is cleared when reset.

Executing the "return from interrupt" instructions, RETI, will exit the interrupt service program and set the GIE bit to 1, thereby re-allowing unmasked interrupt.

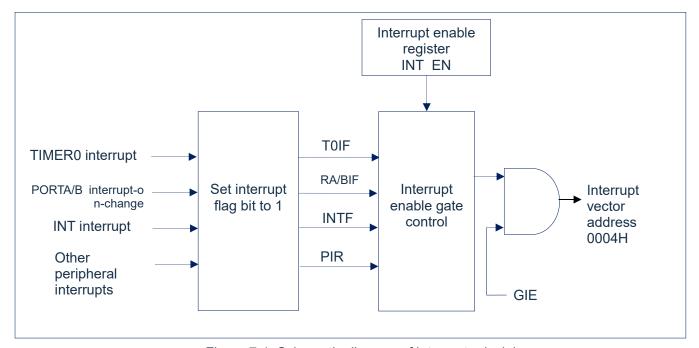


Figure 7-1: Schematic diagram of interrupt principle



7.2 Interrupt control register

7.2.1 Interrupt control register

Interrupt control register (INTCON) is a readable and writable register, including the INT interrupt and the enable and flag bits for PORTB port interrupt on change.

When an interrupt occurs, regardless of the state of the corresponding interrupt enable bit or the global enable bit GIE (in the INTCON register), the interrupt flag bit will be set to 1. The user software should ensure that the corresponding interrupt flag bit is cleared before allowing an interrupt.

Interrupt control register INTCON (0BH)

0BH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	0	0	0	0	0

Bit7	GIE:	Global interrupt enable bit;
	1=	Enable all unshielded interrupt;
	0=	Disable all interrupt
Bit6	PEIE:	Peripheral interrupt enable bit;
	1=	Enable all unshielded peripherals interrupt;
	0=	Disable all peripherals interrupt.
Bit5	T0IE:	TIMER0 overflow interrupt enable bit;
	1=	Enable TIMER0 interrupt;
	0=	Disable TIMER0 interrupt
Bit4	INTE:	INT external interrupt enable bit;
	1=	Enable INT external interrupt;
	0=	Disable INT external interrupt
Bit3	RBIE:	PORTB level change interrupt enable bit (1);
	1=	Enable PORTB level change interrupt;
	0=	Disable PORTB level change interrupt
Bit2	T0IF:	TIMER0 overflow interrupt enable bit (2);
	1=	TMR0 register overflow already (must clear through software);
	0=	TMR0 register not overflow
Bit1	INTF:	INT external interrupt flag bit;
	1=	INT external interrupt happens (must clear through software);
	0=	INT external interrupt not happen
Bit0	RBIF:	PORTB level change interrupt flag bit;
	1=	The level of at least one pin in the PORTB port has changed (must clear through
		software);
	0=	None of the PORTB universal I/O pin status has changed.

Note:

- 1. The IOCB register must also be enabled, and the corresponding port must be set to input state.
- 2. The T0IF bit is set as 1 when TMR0 rolls over to 0. Reset will not change TMR0 and should be initialized before clearing the T0IF bit.



7.2.2Peripheral interrupt enable register

The peripheral interrupt enable register has PIE1, before allowing any peripheral interrupt, you must first set the PEIE bit of the INTCON register to 1.

Peripheral interrupt enable register PIE1 (0EH)

0EH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PIE1			CMPIE	PWMIE	RAIE		TMR2IE	
R/W			R/W	R/W	R/W		R/W	
Reset value			0	0	0		0	

Bit7~Bit6	Unused	
Bit5	CMPIE:	Comparator interrupt enable bit
	1=	Enable comparator interrupt
	0=	Disable comparator interrupt
Bit4	PWMIE:	PWM interrupt enable bit (PWM0/1/2/3)
	1=	Enable PWM interrupt
	0=	Disable PWM interrupt
Bit3	RAIE:	PORTA interrupt-on-change enable bit
	1=	Enable PORTA interrupt-on-change
	0=	Disable PORTA interrupt-on-change
Bit2	Unused	
Bit1	TMR2IE:	TIMER2 and PR2 match interrupt enable bit
	1=	Enable TMR2 and PR2 match interrupt
	0=	Disable TMR2 and PR2 match interrupt
Bit0	Unused	



7.2.3 Peripheral interrupt request register

The peripheral interrupt request register is PIR1. When an interrupt condition is generated, the interrupt flag bit will be set to 1 regardless of the status of the corresponding interrupt enable bit or the global enable bit GIE. The user software should ensure that the corresponding interrupt flag bit is cleared before allowing an interrupt.

Peripheral interrupt request register PIR1(0DH)

0DH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PIR1			CMPIF	PWMIF	RAIF		TMR2IF	
R/W			R/W	R/W	R/W		R/W	
Reset value			0	0	0		0	

Bit7~Bit6	Unused	
Bit5	CMPIF:	Comparator interrupt flag bit (must be cleared by software)
	1=	Comparator interrupt occurs
	0=	No comparator interrupt occurred
Bit4	PWMIF:	PWM interrupt flag bits (PWM0/1/2/3) (must be cleared by software)
	1=	PWM interrupt occurs
	0=	No PWM interrupt occurred
Bit3	RAIF:	PORTA interrupt-on-change flag bit
	1=	PORTA port where the level of at least one pin has changed (must be
		cleared by software).
	0=	None of the PORTA general I/O pins have changed their state.
Bit2	Unused	
Bit1	TMR2IF:	TIMER2 and PR2 match interrupt flag bit (must be cleared by software)
	1=	TMR2 has matched with PR2 interrupt.
Bit0	0=	No interrupt caused by TMR2 matching with PR2.
	Unused	



7.3 Protection methods for interrupt

After an interrupt request occurs and is responded, the program goes to 0004H to execute the interrupt subroutine. Before responding to the interrupt, the contents of ACC and STATUS must be saved. The chip does not provide dedicated stack saving and unstack recovery instructions, and the user needs to protect ACC and STATUS by himself to avoid possible program operation errors after the interrupt ends.

Example: Stack protection for ACC and STATUS

		CC and STATUS	
	ORG	0000H	
	JP	START	;start of user program address
	ORG	0004H	
	JP	INT_SERVICE	;interrupt service program
	ORG	0008H	
START:			
INT_SERVICE:			
PUSH:			;entrance for interrupt service program, save ACC and
	LD	ACC_BAK,A	;save the value of ACC (ACC_BAK needs to be defined)
	SWAPA	STATUS	
	LD	STATUS_BAK,A	;save the value of STATUS (STATUS_BAK needs to be
			AAIIIVAA
POP:			;exit for interrupt service program, restore ACC and
	SWAPA	STATUS_BAK	
	LD	STATUS,A	;restore STATUS
	SWAPR	ACC_BAK	;restore ACC
	SWAPA	ACC_BAK	
	RETI		

7.4 Interrupt priority and multi-interrupt nesting

The priority of each interrupt of the chip is equal. When an interrupt is in progress, it will not respond to the other interrupt. Only after the "RETI" instructions are executed, the next interrupt can be responded to.

When multiple interrupts occur at the same time, the MCU does not have a preset interrupt priority. First, the priority of each interrupt must be set in advance; second, the interrupt enable bit and the interrupt control bit are used to control whether the system responds to the interrupt. In the program, the interrupt control bit and interrupt request flag must be checked.



8. TIMERO

8.1 TIMER0 overview

TIMER0 is composed of the following functions:

- 8-bit timer/counter register (TMR0);
- ◆ 8-bit pre-scaler (shared with watchdog timer);
- Programmable internal or external clock source;
- Programmable external clock edge selection;
- Overflow interrupt.

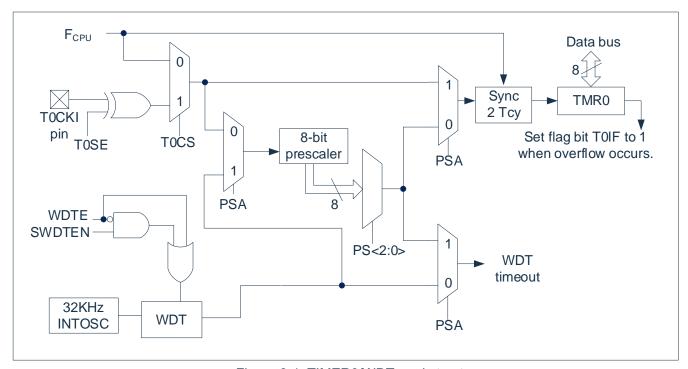


Figure 8-1: TIMER0/WDT mod structure

Note:

- 1. TOSE, TOCS, PSA, PS<2:0> are the bits in OPTION_REG register.
- 2. SWDTEN is a bit in the OSCCON register.
- 3. WDTEN bit is in CONFIG.



8.2 Working principle of TIMER0

TIMER0 mod can be used as an 8-bit timer or an 8-bit counter.

8.2.1 8-bit timer mode

When used as a timer, the TIMER0 mod will be incremented every instruction period (without prescaler). The timer mode can be selected by clearing the T0CS bit of the OPTION_REG register to 0. If a write operation is performed to the TMR0 register, the next two instruction periods will be prohibited from incrementing. The value written to the TMR0 register can be adjusted so that a delay of two instruction periods is included when writing to TMR0.

8.2.2 8-bit counter mode

When used as a counter, the TIMER0 mod will increment on every rising or falling edge of the T0CKI pin. The incrementing edge depends on the T0SE bit of the OPTION_REG register. The counter mode can be selected by setting the T0CS bit of the OPTION_REG register to 1.

8.2.3 Software programmable pre-scaler

TIMER0 and watchdog timer (WDT) share a software programmable pre-scaler, but they cannot be used at the same time. The allocation of the pre-scaler is controlled by the PSA bit of the OPTION_REG register. To allocate the pre-scaler to TIMER0, the PSA bit must be cleared to 0.

TIMER0 mod has 8 selections of prescaler ratio, ranging from 1:2 to 1:256. The prescaler ratio can be selected through the PS<2:0> bits of the OPTION_REG register. To make TIMER0 mod have a 1:1 prescaler, the pre-scaler must be assigned to the WDT mod.

The pre-scaler is not readable and writable. When the pre-scaler is assigned to the TIMER0 mod, all instructions written to the TMR0 register will clear the pre-scaler. When the pre-scaler is assigned to the WDT, the CLRWDT instructions will also clear the pre-scaler and WDT.

8.2.4 Switch prescaler between TIMER0 and WDT module

Whether to use the prescaler from TIMER0 or WDT is completely controlled by software and can be changed dynamically. In order to avoid undesired chip reset, the following instruction should be executed when switching from TIMER0 to WDT.

CLR	TMR0	;clear TMR0
CLRWDT		;clear WDT
LDIA	B'00xx1111'	
LD	OPTION_REG,A	
LDIA	B'00xx1xxx'	;set new pre-scaler
LD	OPTION_REG,A	

To change the pre-scaler from WDT to TIMER0 mod, the following sequence of instructions must be executed.

Ī	CLRWDT		;clear WDT
	LDIA	B'00xx0xxx'	;set new pre-scaler
	LD	OPTION_REG,A	



8.2.5 TIMER0 interrupt

When the TMR0 register overflows from FFh to 00h, a TIMER0 interrupt is generated. Every time the TMR0 register overflows, regardless of whether TIMER0 interrupt is allowed, the T0IF interrupt flag bit of the INTCON register will be set to 1. The T0IF bit must be cleared in software. TIMER0 interrupt enable bit is the T0IE bit of the INTCON register.

Note: The TIMER0 interrupt cannot wake up the processor because the timer is off in the sleep state.



8.3 TIMER0 related registers

There are two registers related to TIMER0, an 8-bit timer/counter (TMR0), and an 8-bit programmable control register (OPTION_REG).

TMR0 is an 8-bit readable and writable timer/counter, OPTION_REG is an 8-bit write-only register, the user can change the value of OPTION_REG to change the working mode of TIMER0, etc. Please refer to Section 2.6 Prescaler Register (OPTION_REG) Application.

8-bit timer/counter TMR0 (81H)

		,						
81H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
TMR0								
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	Х	Х	Х	Χ	Х	Χ	Χ	Х

OPTION_REG register (01H)

01H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
OPTION_REG		INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0
R/W		R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value		1	1	1	1	0	1	1

Bit7	Unused	
Bit6	INTEDG:	Interrupt edge selection bit.
	1=	The rising edge of the INT pin triggers interrupt.
	0=	The falling edge of the INT pin triggers interrupt.
Bit5	T0CS:	TMR0 clock source selection bit.
	1=	Transition edge of T0CKI pin.
	0=	Internal instruction period clock (F _{CPU}).
Bit4	T0SE:	TIMER0 clock source edge selection bit.
	1=	Increment when the TOCKI pin signal transitions from high to low.
	0=	Increment when the TOCKI pin signal transitions from low to high.
Bit3	PAS:	Pre-scaler allocation bit.
	1=	Pre-scaler allocated to WDT.
	0=	Pre-scaler allocated toTIMER0 mod.
Bit2~Bit0	PS2~PS0:	Pre-allocated parameter configuration bits.

PS2	PS1	PS0	TMR0 frequency division ratio	WDT frequency division ratio
0	0	0	1:2	1:1
0	0	1	1:4	1:2
0	1	0	1:8	1:4
0	1	1	1:16	1:8
1	0	0	1:32	1:16
1	0	1	1:64	1:32
1	1	0	1:128	1:64
1	1	1	1:256	1:128



9. TIMER2

9.1 TIMER2 overview

TIMER2 is an 8-bit timer/counter with the following characteristics:

- 1. 8-bit timer register (TMR2)
- 2. 8-bit period register (PR2)
- 3. Interrupt when TMR2 matches PR2
- 4. Software programmable prescaler ratio (1:1, 1:4 and 1:16)
- 5. Software programmable postscaler ratio (1:1 to 1:16)
- 6. External 32.768KHz oscillating clock can be selected

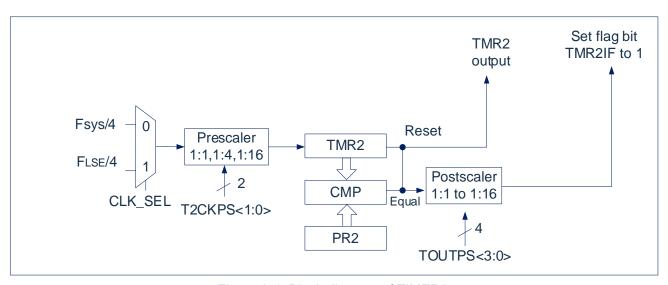


Figure 9-1: Block diagram of TIMER2



9.2 Working principle of TIMER2

The input clock to the TIMER2 module is the system command clock ($F_{SYS}/4$) or an external 32.768 kHz oscillation (F_{LSE}). The clock is input to the TIMER2 prescaler, which is available in the following ratios: 1:1, 1:4 or 1:16. The output of the prescaler is then used to increment the TMR2 register.

Continue to compare the values of TMR2 and PR2 to determine when they match. TMR2 will increase from 00h until it matches the value in PR2. When a match occurs, the following two events will occur:

- TMR2 is reset to 00h in the next increment period;
- TIMER2 post-scaler increment.

The matching output of the TIMER2 and PR2 comparator is then input to the post-scaler of TIMER2. The post-scaler has a prescaler ratio of 1:1 to 1:16 to choose from. The output of the TIMER2 post-scaler is used to make PIR1 The TMR2IF interrupt flag bit of the register is set to 1.

Both TMR2 and PR2 registers can be read and written. At any reset, TMR2 register is set to 00h and PR2 register is set to FFh.

Enable TIMER2 by setting the TMR2ON bit of the T2CON register; disable TIMER2 by clearing the TMR2ON bit.

The TIMER2 pre-scaler is controlled by the T2CKPS bit of the T2CON register; the TIMER2 postscaler is controlled by the TOUTPS bit of the T2CON register.

The pre-scaler and postscaler counters are cleared under the following conditions:

- 1. When TMR2ON=0.
- 2. Any device reset (power-on reset, watchdog timer reset or undervoltage reset) occurs.

Note: Writing to T2CON does not clear TMR2. When TMR2ON=0, the TMR2 register cannot be written.



9.3 TIMER2 related registers

There are 3 registers related to TIMER2, namely data register TMR2, period register PR2 and control register T2CON.

TIMER2 data register TMR2 (12H)

12H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
TMR2								
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	0	0	0	0	0

TIMER2 period register PR2 (11H)

			,					
11H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PR2								
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	1	1	1	1	1	1	1	1

TIMER2 control register T2CON(13H)

13H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
T2CON	CLK_SEL	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	0	0	0	0	0

CLK_SEL: Clock source selection Bit7 1= Select external F_{LSE}/4 as TMR2 clock source (continue counting in sleep state) Select internal F_{SYS}/4 as TMR2 clock source Bit6~Bit3 TOUTPS<3:0>: TIMER2 output postscaler ratio select bit =0000 0001= 1:2 0010= 1:3 0011= 1:4 0100= 1:5 0101= 1:6 0110= 1:7 0111= 1:8 1000= 1:9 1001= 1:10 1010= 1:11 1011= 1:12 1100= 1:13 1101= 1:14 1110= 1:15

1111= Bit2 TMR2ON: TIMER2 enable bit

> 1= Enable TIMER2 Disable TIMER2

Bit1~Bit0 T2CKPS<1:0>: TIMER2 clock prescaler ratio select bit

1:16

00= 01= 4 1x = 16



10. 10-Bit PWM Module

The chip contains a 10-bit PWM module, which can be configured as 4 common periods, independent duty cycle outputs or 1 group complementary output.

10.1 Pin configuration

The corresponding PWM pin should be configured as output by setting the corresponding TRIS control bit to 0.

10.2 Related register description

PWM control register PWMCON0(15H)

15H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWMCON0	CLKDIV[2:0]			PWM4EN	PWM3EN	PWM2EN	PWM1EN	PWM0EN
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	0	0	0	0	0

Bit7~Bit5 CLKDIV[2:0]: PWM clock frequency division

111= F_{HSI}/128 110= F_{HSI}/64 101= F_{HSI}/32 100= F_{HSI}/16 011= F_{HSI}/8 010= F_{HSI}/4 001= F_{HSI}/2

 $000 = F_{HSI}/1$

Bit4~Bit0 PWM0/1/2/3/4EN: PWM0/1/2/3/4 enable bit

1= Enable PWM0/1/2/3/4 0= Disable PWM0/1/2/3/4



PWM control register PWMCON1(16H)

16H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWMCON1		PWM_IOSEL	PWM2DTEN	PWM0DTEN			DT_DI	V<1:0>
R/W		R/W	R/W	R/W			R/W	R/W
Reset value		0	0	0			0	0

Bit7 Unused

Bit6 PWM_IOSEL: PWM output port selection

1= PWM0~PWM4 are respectively on RA5, RB7, RB6, RB5, RB4 0= PWM0~PWM4 are respectively on RB0, RB1, RA2, RA3, RB2

Bit5 PWM2DTEN: PWM2 dead zone enable bit.

1= Enable the dead zone function for PWM2. PWM2 and PWM3 form a

complementary output pair.

0= Disable the dead zone function for PWM2.

Bit4 PWM0DTEN: PWM0 dead zone enable bit.

1= Enable the dead zone function for PWM0. PWM0 and PWM1 form a

complementary output pair.

0= Disable the dead zone function for PWM0.

Bit3~Bit2 Unused

Bit1~Bit0 DT_DIV[1:0] Dead zone clock source division

11= F_{HSI}/8 10= F_{HSI}/4 01= F_{HSI}/2 00= F_{HSI}/1

PWM control register PWMCON2(1DH)

1DH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWMCON2				PWM4DIR	PWM3DIR	PWM2DIR	PWM1DIR	PWM0DIR
R/W				R/W	R/W	R/W	R/W	R/W
Reset value				0	0	0	0	0

Bit7~Bit5 Unused

Bit4~Bit0 PWM0/1/2/3/4DIR PWM output reverse control bit

1= PWM0/1/2/3/4 reverse output 0= PWM0/1/2/3/4 normal output

PWM0~PWM3 period low bit register PWMTL (17H)

17H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
PWMTL		PWMT<7:0>							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset value	0	0	0	0	0	0	0	0	

Bit7~Bit0 PWMT[7:0]: PWM0~PWM3 period low 8 bits



PWM4 period low bit register PWMT4L(1CH)

1CH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWMT4L				PWM4	T<7:0>			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	0	0	0	0	0

Bit7~Bit0 PWM4T<7:0>: PWM4 period low 8 bits

Period high bit register PWMTH (18H)

18H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWMTH			PWMD4<9:8>		PWM4T<9:8>		PWMT<9:8>	
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			0	0	0	0	0	0

Bit7~Bit6 Unused

Bit5~Bit4 PWMD4<9:8>: Higher 2 bits of PWM4 duty register
Bit3~Bit2 PWM4T<9:8>: Higher 2 bits of PWM4 period register

Bit1~Bit0 PWMT<9:8>: Higher 2 bits of PWM0~PWM3 period register

Note: Writing PWMD4<9:8> does not take effect immediately, it needs to be written to PWMD4L to take effect.

PWM0 duty cycle low bit register PWMD0L (19H)

19H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
PWMD0L		PWMD0<7:0>							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset value	0	0	0	0	0	0	0	0	

Bit7~Bit0 PWMD0<7:0>: PWM1 duty cycle low 8 bits PWM1 duty cycle low bit register PWMD1L (1AH)

1AH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
PWMD1L		PWMD1<7:0>							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset value	0	0	0	0	0	0	0	0	

Bit7~Bit0 PWMD1<7:0>: PWM1 duty cycle low 8 bits

PWM2 duty cycle low bit register PWMD2L (9BH)

9BH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
PWMD2L		PWMD2[7:0]							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset value	0	0	0	0	0	0	0	0	

Bit7~Bit0 PWMD2[7:0]: PWM0 duty cycle low 8 bits



PWM3 duty cycle low bit register PWMD3L (9CH)

9CH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
PWMD3L		PWMD3[7:0]							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset value	0	0	0	0	0	0	0	0	

Bit7~Bit0 PWMD3[7:0]: PWM3 duty cycle low 8 bits

PWM4 duty cycle low bit register PWMD4L (1BH)

1BH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
PWMD4L		PWMD4<7:0>							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset value	0	0	0	0	0	0	0	0	

Bit7~Bit0 PWMD4<7:0>: PWM4 duty cycle low 8 bits

PWM0 and PWM1 duty cycle high bit register PWMD01H (1EH)

1EH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWMD01H			PWMD1<9:8>				PWMD	0<9:8>
R/W			R/W	R/W			R/W	R/W
Reset value			0	0			0	0

Bit7~Bit6 Unused

Bit5~Bit4 PWMD1<9:8>: PWM1 duty cycle high 2 bits

Bit3~Bit2 Unused

Bit1~Bit0 PWMD0<9:8>: PWM0 duty cycle high 2 bits

Note: Writing PWMD0<9:8> does not take effect immediately, it needs to write PWMD0L to take effect. Writing PWMD1<9:8> does not take effect immediately, it needs to write PWMD1L to take effect.

PWM2 and PWM3 duty cycle high bit register PWMD23H (9EH)

9EH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWMD23H			PWMD3[9:8]				PWME	02[9:8]
R/W			R/W	R/W			R/W	R/W
Reset value			0	0			0	0

Bit7~Bit6 Unused

Bit5~Bit4 PWMD3[9:8]: PWM3 duty cycle high 2 bits

Bit3~Bit2 Unused

Bit1~Bit0 PWMD2[9:8]: PWM2 duty cycle high 2 bits

Note: Writing PWMD2<9:8> does not take effect immediately, it needs to write PWMD2L to take effect. Writing PWMD3<9:8> does not take effect immediately, you need to write PWMD3L to take effect.



PWM0 and PWM1 dead time register PWM01DT(1FH)

1FH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWM01DT			PWM01DT<5:0>					
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			0	0	0	0	0	0

Bit7~Bit6 Unused

Bit5~Bit0 PWM01DT<5:0>: PWM0 and PWM1 dead time

PWM2 and PWM3 dead time register PWM23DT(9DH)

9DH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
PWM23DT			PWM23DT<5:0>					
R/W			R/W	R/W	R/W	R/W	R/W	R/W
Reset value			0	0	0	0	0	0

Bit7~Bit6 Unused

Bit5~Bit0 PWM23DT<5:0>: PWM2 and PWM3 dead time



10.3 10-bit PWM register write sequence

Since the 10-bit PWM duty cycle value is allocated in two registers, when modifying the duty cycle, the program always modifies these two registers successively. In order to ensure the correctness of the duty cycle value, the chip is designed with an internal cache loading function. To operate the 10-digit duty cycle value, the following sequence should be strictly followed.

- 1) Write the higher 2-bit value, the high 2-bit value is just written to the internal cache;
- 2) Write the lower 8 bits, then the full 10-bit duty cycle value is latched;
- 3) The above operations are only for PWM0, PWM1, PWM2, PWM3, PWM4 duty cycle registers.

10.4 10-bit PWM period

The PWM period is specified by writing the PWMTH and PWMTL registers.

Formula 1: PWM cycle calculation formula.

PWM period=[PWMT+1]* T_{HSI} *(CLKDIV prescaler value)

Note: T_{HSI}=1/F_{HSI}

When the PWM cycle counter is equal to PWMT, the following three events occur during the next incremental counting cycle:

- PWM period counter is cleared;
- PWMx pin is set to 1;
- New period of PWM is latched;
- New duty cycle of PWM is latched;
- Generate a PWM interrupt flag bit (No interrupt for PWM4);

10.5 10-bit PWM duty cycle

The PWM duty cycle can be specified by writing a 10-bit value to the following multiple registers: PWMDxL, PWMDxxH.

The PWM duty cycle can be specified by writing a 10-bit value to the following multiple registers:

Formula 2: Pulse width calculation formula

Pulse width = $(PWMDx[9:0]+1)^*T_{HSI}^*(CLKDIV)$ prescaler value)

Formula 3: PWM duty cycle calculation formula

Duty cycle=
$$\frac{PWMDx[9:0]+1}{PWMT[9:0]+1}$$

Internal chip is used to provide double buffering for the PWM duty cycle. This double buffering structure is extremely important to avoid glitches during the PWM operation.

10.6 System clock frequency change

The PWM frequency is only related to the chip oscillation clock. Any change in the system clock frequency will not change the PWM frequency.



10.7 Programmable dead time delay mode

The complementary output mode can be enabled by setting PWMxDT_EN, and the dead time delay function is automatically enabled after the complementary output is enabled.

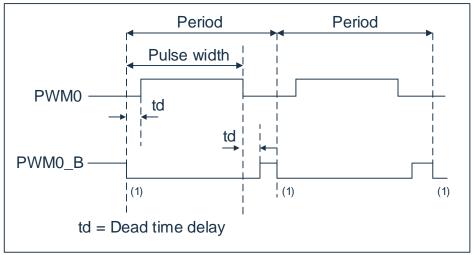


Figure 10-1: Example of PWM dead time delay output

The dead time calculation formula is:

td=(PWMxxDT[5:0]+1)*T_{HSI}*(DT_DIV prescaler time)

10.8 10-bit PWM configuration

The following steps should be performed when using the PWM module.

- 1. Set the corresponding TRIS bit to 1 to make it as an input pin.
- 2. Set the PWM period by loading the PWMTH and PWMTL registers.
- 3. Set the PWM duty cycle by loading the PWMDxL and PWMDxxH registers.
- 4. Clear the PWMIF flag bit.
- 5. Set the PWMENx bit to enable the corresponding PWM outputs.
- 6. After the new PWM period starts, enable PWM output:
 - Wait for PWMIF bit set to 1.
 - Enable the PWM pin output driver by clearing the corresponding TRIS bit.



11. Comparator (COMP)

11.1 Features

- ♦ Internally integrated with one comparator.
- ◆ Comparator offset voltage is ≤ ±13mV.
- ◆ Input common-mode voltage range: 0V~VDD-1.3V.
- ◆ Built-in resistor divider module with VDD as the reference voltage.
- ◆ The comparator result can be triggered by either rising or falling edge and generate an interrupt.
- The comparator result can be output from RB0 port and supports inverted output.

11.2 Block diagram

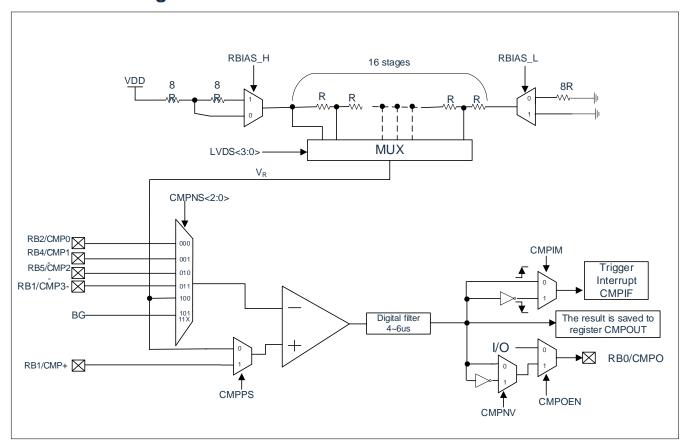


Figure 11-1: Functional block diagram of comparator



11.3 Comparator related function

11.3.1 Comparator function description

The SC8P054 chip integrates one comparator module internally, as shown in Figure 11-1. The positive input of the comparator can be used for selecting the CMP+ port or the internal resistor voltage divider output V_R by configuring CMPPS bit of the CMPCON0 register. The negative input can be used for selecting the CMPx- port, the internal resistor voltage divider output V_R , or the 1.2V BG voltage by configuring the CMPNS<2:0> bits of the CMPCON0 register. When the voltage at the positive input of the comparator is greater than the voltage at the negative input, the comparator outputs 1 after digital filtering. Conversely, if the voltage at the positive input is less than the voltage at the negative input, the comparator outputs 0 after digital filtering.

11.3.2 Comparator internal resistor voltage divider output

The comparator integrates an internal resistor voltage divider module with a reference voltage of VDD. Different resistor voltage divider outputs V_R can be obtained by configuring the values of the control bits RBIAS_H, RBIAS_L, and LVDS<3:0> of the CMPCON1 register. The four calculation formulas for V_R are as follows:

RBIAS_H	RBIAS_L	V _R calculation formula
0	0	$V_R = \frac{1}{4} *VDD + \frac{n+1}{32} *VDD$
0	1	$V_R = \frac{n+1}{24} *VDD$
1	0	$V_R = \frac{1}{5} \times VDD + \frac{n+1}{40} \times VDD$
1	1	$V_R = \frac{n+1}{32} *VDD$

Note: n is the value of LVDS<3:0>, i.e., n = 0, 1, 2, ..., 14, 15.

11.3.3 Comparator for monitoring power supply voltage

According to the comparator structure block diagram in Figure 11-1 and the formula in section 11.3.2, when the negative end of the comparator selects BG 1.2V, and the positive end selects the internal resistor voltage divider output V_R , the power supply voltage can be monitored by the comparator. When the power supply voltage is lower than the set value, the comparator outputs 0, and when the power supply voltage is higher than the set value, the comparator outputs 1. By configuring the values of RBIAS_H, RBIAS_L, LVDS[3:0], different voltage monitoring points can be set as follows.

RBIAS_H	RBIAS_L	LVDS[3:0]	Monitoring value (V)	RBIAS_	HRBIAS_L	LVDS[3:0]	Monitoring value (V)	RBIAS_I	RBIAS_L	LVDS[3:0]	Monitoring value (V)
0	1	0101	4.80	0	0	0100	2.95	1	0	1101	2.18
1	0	0010	4.36	0	1	1001	2.88	0	0	1001	2.13
0	0	0000	4.27	1	0	1000	2.82	1	0	1110	2.09
0	1	0110	4.11	0	0	0101	2.74	0	1	1101	2.06
1	0	0011	4.00	1	0	1001	2.67	0	0	1010	2.02
0	0	0001	3.84	0	1	1010	2.62	1	0	1111	2.00
1	0	0100	3.69	0	0	0110	2.56	-	-	-	-
0	1	0111	3.60	1	0	1010	2.53	-	-	-	-
0	0	0010	3.49	0	0	0111	2.40	-	-	-	-
1	0	0101	3.43	1	0	1100	2.29	-	-	-	-
0	0	0011	3.20	0	0	1000	2.26	-	-	-	-



11.3.4 Comparator interrupt usage

To use the interrupt function of the comparator, the comparator interrupt can be enabled through the following configuration steps:

- Configure the CMPPS bit of the CMPCON0 register to select the positive input.
- ◆ Configure the CMPNS<2:0> bits of the CMPCON0 register to select the negative input.
- ◆ Configure the CMPIM bit of the CMPCON1 register to select the rising or falling edge trigger for the interrupt.
- Set the CMPEN bit of the CMPCON0 register to enable the comparator.
- Delay for 10us.
- Clear the CMPIF bit of the PIR1 register.
- ◆ Set the CMPIE bit of the PIE1 register to 1 to enable the comparator interrupt.
- ◆ Set the PEIE and GIE bits of the INTCON register to 1 to enable peripheral and global interrupts.

11.3.5 Comparator interrupt sleep wake-up

The comparator interrupt can wake up the chip from sleep mode. The specific configuration can be found in the following program routine:

Example: Comparator interrupt sleep wake-up program

CLEED MODE:		-	
SLEEP_MODE:			
	LDIA	B'00000110'	
	LD	TRISB,A	;Configure RB1/CMP+ and RB2/CMP0- as input ports
			;Disable other functions
	LDIA	00H	
	LD	CMPCON0,A	;CMPNS<2:0>=000, select RB2/CMP0- as the negative input
	SETB	CMPCON0,6	;CMPPS=1, select RB1/CMP+ as the positive input
	SETB	CMPCON1,6	;ANSEL=1, set CMP+ and CMP0- as analog ports to reduce sleep power consumption
	SETB	CMPCON1,7	;CMPIM=1, select falling edge trigger for the comparator interrupt
	SETB	CMPCON0,7	;Enable the comparator
	CALL	DELAY10US	;Delay to ensure stable output from the comparator after enabling it
	CLRB	PIR1,5	;Clear CMPIF (necessary)
	SETB	PIE1,5	;Enable the comparator interrupt
	SETB	INTCON,6	;Enable peripheral interrupts
	SETB	INTCON,7	;Enable global interrupts, the program will jump to the interrupt vector address 0004H after waking up
	CLRWDT		;Clear the WDT
	STOP		Execute the STOP instruction
	NOP		
	NOP		



11.3.6 Comparator result output pin configuration

After digital filtering, the result of the comparator can be obtained by reading the CMPOUT bit of the CMPCON0 register. It can also be output to the RB0/CMPO pin through the following configuration steps:

- ◆ Set TRISB0 to 0 to configure RB0/CMPO as an output pin.
- ◆ Configure the CMPNV bit of the CMPCON0 register to select normal or inverted output.
- ◆ Set the CMPOEN bit of the CMPCON0 register to 1 to enable the output of CMPOUT to the RB0/CMPO pin.



11.4 Related registers

Comparator control register CMPCON0(0FH)

0FH	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
CMPCON0	CMPEN	CMPPS	CMPNS2	CMPNS1	CMPNS0	CMPNV	CMPOUT	CMPOEN
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R	R/W
Reset value	0	0	0	0	0	0	0	0

Bit7 CMPEN: CMP enable bit

1= Enable CMP

0= Disable CMP

Bit6 CMPPS: CMP positive input select bit

1= CMP+ port voltage

0= VDD voltage after dividing by internal resistor

Bit5~Bit3 CMPNS<2:0>: CMP negative input select bit

000= CMP0- port voltage 001= CMP1- port voltage 010= CMP2- port voltage 011= CMP3- port voltage

100= VDD voltage after dividing by internal resistor

101= BG 11x= BG

Bit2 CMPNV: CMPO port output inverse control bit

1= Invert CMPOUT output at CMPO port0= Normal CMPOUT output at CMPO port

Bit1 CMPOUT: CMP result bit

Bit0 CMPOEN: CMPO port output enable bit

1= Enable CMPOUT output at CMPO port0= Disable CMPOUT output at CMPO port

Comparator control register CMPCON1(10H)

10H	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
CMPCON1	CMPIM	AN_EN	RBIAS_H	RBIAS_L		LVDS	<3:0>	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset value	0	0	0	0	0	0	0	0

Bit7 CMPIM: CMP interrupt trigger edge selection

1= Falling edge of the CMP output triggers an interrupt

0= Rising edge of CMP output triggers interrupt

Bit6 AN_EN: Analog port enable bit, enables analog functionality for CMP+ and CMPX-

1= Analog port0= Digital port

Bit5 RBIAS_H: Specific usage refers to the comparator block diagram
Bit4 RBIAS L: Specific usage refers to the comparator block diagram

Bit3~Bit0 LVDS<3:0>: Internal resistor divider ratio selection bit

Note: The AN EN bit is only valid for the IO port selected for comparator function.



12. Electrical Parameters

12.1 Limit parameters

Supply voltage	GND-0.3V~GND+6.0V
Storage temperature	50°C~125°C
Working temperature	40°C~85°C
Port input voltage	GND-0.3V~VDD+0.3V
Maximum positive current for all ports	200mA
Maximum negative current for all ports	

Note: If the device operating conditions exceed the above "limit parameters", it may cause permanent damage to the device. The above values are only the maximum value of the operating conditions. We do not recommend that the device operate outside the range specified in this specification. The stability of the device will be affected if it is operated for a long period of time under extreme conditions.



12.2 DC characteristics

(VDD=5V, T_A= 25°C, unless otherwise specified)

C) make al	lta in	Te	est condition	Min	T	May	1.1
Symbol	Item	VDD	Condition	Min.	Тур.	Max.	Unit
VDD	Operating voltage	-	F _{SYS} =16MHz/2T	3.0	-	5.5	V
VDD	Operating voltage	-	F _{SYS} =16MHz/4T	1.8	-	5.5	V
		5V	F _{SYS} =16MHz, disable all analog modules.	-	2.5	-	mA
I _{DD}	Operating current	5V	F _{SYS} =8MHz, disable all analog modules.	-	1.0	-	mA
טטו	Operating current	3V	F _{SYS} =16MHz, disable all analog modules.	-	1.5	-	mA
		3V	F _{SYS} =8MHz, disable all analog modules.	-	0.5	-	mA
		5V	LVR=DIS WDT=DIS	-	1.1	5	uA
Istb	Static current	3V	LVR=DIS WDT=DIS	-	0.6	3	uA
ISIB		5V	LVR=DIS WDT=EN	-	4.8	12	uA
		3V	LVR=DIS WDT=EN	-	2.1	5.5	uA
V _{IL}	Low level input voltage	-		-	-	0.3VDD	V
V _{IH}	High level input voltage	-		0.7VDD	-	-	V
V _{OH}	High level output voltage	-	No load	0.9VDD	-	-	V
VoL	Low level output voltage	-	No load	-	-	0.1VDD	V
Rрн	Pull-up resistor	5V	Vo=0.5VDD	-	51	-	ΚΩ
™ PH	value	3V	Vo=0.5VDD	-	85	-	ΚΩ
D-:	Pull-down resistor	5V	Vo=0.5VDD	-	33	-	ΚΩ
R _{PL}	value	3V	Vo=0.5VDD	-	45	-	ΚΩ
loL	Output port positive	5V	V _{OL} =0.3VDD	-	37	-	mA
IOL	current	3V	V _{OL} =0.3VDD	-	17	-	mA
Іон	Output port	5V	V _{OH} =0.7VDD	-	-16	-	mA
IOH	negative current	3V	V _{OH} =0.7VDD	-	-7	-	mA
V _{BG}	Internal reference	VDD=2.0~5	.5V T _A =25°C	-3.5%	1.2	+3.5%	V
v BG	voltage 1.2V	VDD=2.0~5	.5V T _A =-40~85°C	-5%	1.2	+5%	V



12.3 Comparator characteristics

(T_A= 25°C, unless otherwise specified)

Symbol	Item	Test condition	Min.	Тур.	Max.	Unit
VDD	Operating voltage range	-	2.0	-	5.5	V
Temp	Temperature range	-	-40	-	85	°C
lwork	Operating aureant	VDD=5V COMP+=2V COMP-=2V	-	34	46	uA
IWOIK	Operating current	VDD=3V COMP+=1V COMP-=1V	-	20	26	uA
l	BG operating	VDD=5V	-	35	46	uA
I _{BG}	current	VDD=3V	-	33	44	uA
V _{IN}	Input common mode voltage range	-	0	-	VDD-1.3	V
Vos	Offset voltage	-	-	-	±13	mV
LSB	Minimum resolution	-	-	10	20	mV
Tr	Response time	-	-	-	6	us
	Internal resistor	VDD=5V V _R >1V	-1%	-	+1%	-
-	voltage divider error	VDD=5V V _R <1V	-2%	-	+ 2%	-

Note: V_R is the internal resistor voltage divider output value.

12.4 Power on reset characteristics

(T_A= 25°C, unless otherwise specified)

Symbol	Item	Test condition	Min.	Тур.	Max.	Unit
T_{VDD}	VDD rising rate	-	0.05			V/ms
V _{LVR1}	LVR set voltage=1.8V	VDD=1.6~5.5V	1.7	1.8	1.9	V
V _{LVR2}	LVR set voltage=2.0V	VDD=1.8~5.5V	1.9	2.0	2.1	V
V _{LVR3}	LVR set voltage=2.5V	VDD=2.3~5.5V	2.4	2.5	2.6	V
V _{LVR4}	LVR set voltage=3.0V	VDD=2.8~5.5V	2.9	3.0	3.1	V

12.5 AC electrical characteristics

(T_A= 25°C, unless otherwise specified)

Symbol	Item	Test	condition	Min.	Tun	Max.	Unit
Symbol	item	VDD	Condition	IVIII I.	Тур.	IVIAX.	Offic
		VDD=2.5~5.5	V Ta=25°C	-20%	32	+20%	KHz
Fwpt	WDT clock source	VDD=1.8~5.5	V T _A =25°C	-30%	32	+30%	KHz
FWDI	VVD1 Clock source	VDD=2.5~5.5	V T _A =-40~85°C	-30%	32	+30%	KHz
		VDD=1.8~5.5	V T _A =-40~85°C	-50%	32	+50%	KHz
		VDD=4.0~5.5	V T _A =25°C	-2.0%	16	+2.0%	MHz
		VDD=2.5~5.5	V T _A =25°C	-2.5%	16	+2.5%	MHz
FINTRC	Internal frequency 16MHz	VDD=1.8~5.5	V T _A =25°C	-4.0%	16	+4.0%	MHz
FINIRC		VDD=4.0~5.5	V T _A = -40~85°C	-3.5%	16	+3.5%	MHz
		VDD=2.5~5.5	V T _A = -40~85°C	-4.0%	16	+4.0%	MHz
		VDD=1.8~5.5	V T _A = -40~85°C	-5.0%	16	+5.0%	MHz



12.6 LSE characteristics

(TA= 25°C, unless otherwise specified)

Symbol	Item	Test condition	Min.	Тур.	Max.	Unit
VDD	Operating voltage range	-	1.8	-	5.5	V
FLSE	LSE oscillator frequency	-	-	32.768	-	KHz
C ₁	OSCIN pin matching capacitance	-	-	22	1	pF
C ₂	OSCOUT pin matching capacitance	-	-	22	•	pF
	LCE anamatina a aumant	VDD=5V C1=22 pF C2=22pF	-	20	-	uA
ILSE	LSE operating current	VDD=3V C1=22 pF C2=22pF	-	8	-	uA
Tues	LSE stabilization time	VDD=5V C1=22 pF C2=22pF	-	260	700	ms
T _{LSE}	LOE Stabilization time	VDD=3V C1=22 pF C2=22pF	-	300	1000	ms

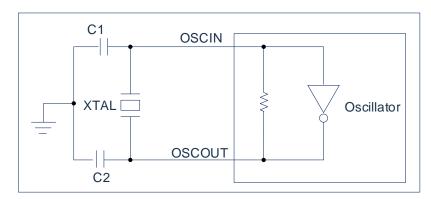


Figure 12-1: LSE typical application circuit



13. Instructions

13.1 Instruction set

mnem	onic	operation	period	symbol
control				1
NOP		Empty operation	1	None
STOP		Enter sleep mode	1	TO,PD
CLRWDT		Clear watchdog timer	1	TO,PD
data trans	sfer	,		1
LD	[R],A	Transfer content to ACC to R	1	LD
LD	A,[R]	Transfer content to R to ACC	1	LD
TESTZ	[R]	Transfer the content of data memory data memory	1	TESTZ
LDIA	i	Transfer i to ACC	1	LDIA
logic ope	ration			
CLRA		Clear ACC	1	Z
SET	[R]	Set data memory R	1	SET
CLR	[R]	Clear data memory R	1	CLR
ORA	[R]	Perform 'OR' on R and ACC, save the result to ACC	1	ORA
ORR	[R]	Perform 'OR' on R and ACC, save the result to R	1	ORR
ANDA	[R]	Perform 'AND' on R and ACC, save the result to ACC	1	ANDA
ANDR	[R]	Perform 'AND' on R and ACC, save the result to R	1	ANDR
XORA	[R]	Perform 'XOR' on R and ACC, save the result to ACC	1	XORA
XORR	[R]	Perform 'XOR' on R and ACC, save the result to R	1	XORR
SWAPA	[R]	Swap R register high and low half byte, save the result to ACC	1	SWAPA
SWAPR	[R]	Swap R register high and low half byte, save the result to R	1	SWAPR
COMA	[R]	The content of R register is reversed, and the result is stored in ACC	1	COMA
COMR	[R]	The content of R register is reversed and the result is stored in R	1	COMR
XORIA	i	Perform 'XOR' on i and ACC, save the result to ACC	1	XORIA
ANDIA	i	Perform 'AND' on i and ACC, save the result to ACC	1	ANDIA
ORIA	i	Perform 'OR' on i and ACC, save the result to ACC	1	ORIA
shift oper	ation			
RRCA	[R]	Data memory rotates one bit to the right with carry, the result is stored in ACC	1	RRCA
RRCR	[R]	Data memory rotates one bit to the right with carry, the result is stored in R	1	RRCR
RLCA	[R]	Data memory rotates one bit to the left with carry, the result is stored in ACC	1	RLCA
RLCR	[R]	Data memory rotates one bit to the left with carry, the result is stored in R	1	RLCR
RLA	[R]	Data memory rotates one bit to the left without carry, and the result is stored in ACC	1	RLA
RLR	[R]	Data memory rotates one bit to the left without carry, and the result is stored in R	1	RLR
RRA	[R]	Data memory does not take carry and rotates to the right by one bit, and the result is stored in ACC	1	RRA
RRR	[R]	Data memory does not take carry and rotates to the right by one bit, and the result is stored in R	1	RRR
increase/				T
INCA	[R]	Increment data memory R, result stored in ACC	1	INCA
INCR	[R]	Increment data memory R, result stored in R	1	INCR
DECA	[R]	Decrement data memory R, result stored in ACC	1	DECA
DECR	[R]	Decrement data memory R, result stored in R	1	DECR





mnemo	onic	operation	period	symbol				
bit operati	on							
CLRB	[R],b	Clear some bit in data memory R	1	CLRB				
SETB	[R],b	Set some bit in data memory R to 1	1	SETB				
math oper	math operation							
ADDA	[R]	ACC+[R]→ACC	1	ADDA				
ADDR	[R]	ACC+[R]→R	1	ADDR				
ADDCA	[R]	ACC+[R]+C→ACC	1	ADDCA				
ADDCR	[R]	ACC+[R]+C→R	1	ADDCR				
ADDIA	i	ACC+i→ACC	1	ADDIA				
SUBA	[R]	[R]-ACC→ACC	1	SUBA				
SUBR	[R]	[R]-ACC→R	1	SUBR				
SUBCA	[R]	[R]-ACC-C→ACC	1	SUBCA				
SUBCR	[R]	[R]-ACC-C→R	1	SUBCR				
SUBIA	i	i-ACC→ACC	1	SUBIA				
HSUBA	[R]	ACC-[R]→ACC	1	HSUBA				
HSUBR	[R]	ACC-[R]→R	1	HSUBR				
HSUBCA	[R]	ACC-[R]- C →ACC	1	HSUBCA				
HSUBCR	[R]	$ACC-[R]-\overline{C}\rightarrow R$	1	HSUBCR				
HSUBIA	i	ACC-i→ACC	1	HSUBIA				
uncondition	onal tran	sfer						
RET		Return from subroutine	2	NONE				
RET	i	Return from subroutine, save I to ACC	2	RET				
RETI		Return from interrupt	2	NONE				
CALL	ADD	Subroutine call	2	CALL				
JP	ADD	Unconditional jump	2	JP				
conditiona	al transfe	er						
SZB	[R],b	If the b bit of data memory R is "0", skip the next instruction	1 or 2	SZB				
SNZB	[R],b	If the b bit of data memory R is "1", skip the next instruction	1 or 2	SNZB				
SZA	[R]	data memory R is sent to ACC, if the content is "0", skip the next instruction	1 or 2	SZA				
SZR	[R]	If the content of data memory R is "0", skip the next instruction	1 or 2	SZR				
SZINCA	[R]	Add "1" to data memory R and put the result into ACC, if the result is "0", skip the next oneinstructions	1 or 2	SZINCA				
SZINCR	[R]	Add "1" to data memory R, put the result into R, if the result is "0", skip the next instruction	1 or 2	SZINCR				
SZDECA	[R]	Data memory R minus "1", the result is put into ACC, if the result is "0", skip the next instruction	1 or 2	SZDECA				
SZDECR	[R]	Data memory R minus "1", put the result into R, if the result is "0", skip the next instruction	1 or 2	SZDECR				



13.2 Instruction description

ADDA [R]

operation: Add ACC to R, save the result to ACC

period:

affected flag bit: C, DC, Z, OV

example:

LDIA ;load 09H to ACC 09H

LD R01,A ;load ACC (09H) to R01

LDIA 077H ;load 77H to ACC

ADDA R01 ;execute: ACC=09H + 77H =80H

ADDR [R]

Add ACC to R, save the result to R operation:

period:

affected flag

C, DC, Z, OV

example:

LDIA 09H ;load 09H to ACC

LD ;load ACC (09H) to R01 R01,A

LDIA 077H ;load 77H to ACC

ADDR R01 ;execute: R01=09H + 77H =80H

ADDCA [R]

Add ACC to C, save the result to ACC operation:

period: 1

affected flag

C, DC, Z, OV bit:

example:

LDIA 09H ; load 09H to ACC

LD R01,A ; load ACC (09H) to R01

LDIA 077H ; load 77H to ACC

;execute: ACC= 09H + 77H + C=80H (C=0) **ADDCA** R01

ACC = 09H + 77H + C = 81H (C=1)



ADDCR [R]

Add ACC to C, save the result to R operation:

period:

affected flag

bit:

C, DC, Z, OV

example:

LDIA 09H ; load 09H to ACC LD R01,A ; load ACC (09H) to R01

LDIA 077H ; load 77H to ACC

; execute: R01 = 09H + 77H + C=80H (C=0) **ADDCR** R01

 $R01 = 09H + 77H + C = 81\dot{H} (C = 1)$

ADDIA i

operation: Add i to ACC, save the result to ACC

period:

affected flag bit:

C, DC, Z, OV

example:

LDIA 09H ;load 09H to ACC

ADDIA 077H ;execute: ACC = ACC(09H) + i(77H)=80H

ANDA [R]

operation: Perform 'AND' on register R and ACC, save the result to ACC

period: 1 affected flag Ζ bit:

example:

;load 0FH to ACC **LDIA** 0FH

;load ACC (0FH) to R01 LD R01,A

;load 77H to ACC **LDIA** 77H

ANDA R01 ;execute: ACC=(0FH and 77H)=07H

ANDR [R]

operation: Perform 'AND' on register R and ACC, save the result to R

period: 1 affected flag Ζ bit:

example:

;load 0FH to ACC LDIA 0FH

;load ACC (0FH) to R01 LD R01,A

;load 77H to ACC **LDIA** 77H

;execute: R01= (0FH and 77H)=07H **ANDR** R01





ANDIA i

operation: Perform 'AND' on i and ACC, save the result to ACC

period: 1

affected flag

bit:

example:

LDIA 0FH ;load 0FH to ACC

ANDIA 77H ;execute: ACC =(0FH and 77H)=07H

CALL add

operation: Call subroutine

Z

2 period:

affected flag

None

bit: example:

CALL LOOP ;Call the subroutine address whose name is defined as "LOOP"

CLRA

ACC clear operation:

period: 1 affected flag Ζ bit:

example:

CLRA ;execute: ACC=0

CLR [R]

Register R clear operation:

period: affected flag Z bit:

example:

CLR R01 ;execute: R01=0

CLRB [R],b

operation: Clear b bit on register R

period:

affected flag bit:

None

example:

;execute: 3rd bit of R01 is 0 **CLRB** R01,3

CLRWDT

Clear watchdog timer operation:

TO, PD

period:

affected flag

bit:

example:

CLRWDT ;watchdog timer clear



COMA [R]

operation: Reverse register R, save the result to ACC

period: 1 affected flag

bit: example:

LDIA 0AH ;load 0AH to ACC

 LD
 R01,A
 ;load ACC (0AH) to R01

 COMA
 R01
 ;execute: ACC=0F5H

COMR [R]

operation: Reverse register R, save the result to R

period: affected flag bit:

Z

1

example:

LDIA 0AH ;load 0AH to ACC

LD R01,A ;load ACC (0AH) to R01
COMR R01 ;execute: R01=0F5H

DECA [R]

operation: Decrement value in register, save the result to ACC

period: 1 affected flag bit: Z

example:

LDIA 0AH ;load 0AH to ACC

LD R01,A ;load ACC (0AH) to R01

DECA R01 ;execute: ACC=(0AH-1)=09H

DECR [R]

operation: Decrement value in register, save the result to R

period: 1
affected flag
bit: Z

example:

LDIA 0AH ;load 0AH to ACC

LD R01,A ;load ACC (0AH) to R01

DECR R01 ;execute: R01=(0AH-1)=09H



HSUBA [R]

operation: ACC subtract R, save the result to ACC

period:

affected flag

C,DC,Z,OV

example:

LDIA 077H ;load 077H to ACC

LD R01,A ;load ACC (077H) to R01

LDIA 080H ;load 080H to ACC

R01 **HSUBA** ;execute: ACC=(80H-77H)=09H

HSUBR [R]

operation: ACC subtract R, save the result to R

1 period:

affected flag

C,DC,Z,OV

example:

bit:

LDIA 077H ;load 077H to ACC

LD R01,A ;load ACC (077H) to R01

H080 **LDIA** ;load 080H to ACC

HSUBR R01 ;execute: R01=(80H-77H)=09H

HSUBCA [R]

operation: ACC subtract C, save the result to ACC

period: 1

affected flag

bit:

C,DC,Z,OV

example:

LDIA 077H ;load 077H to ACC

R01,A ;load ACC (077H) to R01 LD

080H ;load 080H to ACC **LDIA**

HSUBCA R01 ;execute: ACC=(80H-77H- C)= 08H(C=0)

ACC = (80H-77H - C) = 09H(C=1)

HSUBCR [R]

operation: ACC subtract C, save the result to R

period:

affected flag bit:

C,DC,Z,OV

example:

LDIA 077H ;load 077H to ACC

;load ACC (077H) to R01 LD R01,A H080 ;load 080H to ACC **LDIA**

HSUBC R01 ;execute: R01=(80H-77H- C)=08H(C=0) R

R01=(80H-77H-C)=09H(C=1)

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Ζ

[R] **INCA**

Register R increment 1, save the result to ACC operation:

period: affected flag bit:

example:

;load 0AH to ACC 0AH **LDIA** LD R01,A ;load ACC (0AH) to R01

INCA R01 ;execute: ACC=(0AH+1)=0BH

INCR [R]

Register R increment 1, save the result to R operation:

period: 1 Ζ

affected flag bit:

example:

LDIA 0AH ;load 0AH to ACC

LD R01,A ;load ACC (0AH) to R01 **INCR** R01 ;execute: R01=(0AH+1)=0BH

JP add

Jump to add address operation:

2 period: affected flag None bit:

example:

JΡ LOOP ;jump to the subroutine address whose name is defined as "LOOP"

LD **A**,[R]

operation: Load the value of R to ACC

period: 1 affected flag Ζ bit:

example:

:load R01 to ACC A,R01 LD

;load ACC to R02, achieve data transfer from R01→R02 R02,A LD

LD [R],A

Load the value of ACC to R operation:

period: affected flag

bit:

None

example:

09H ;load 09H to ACC **LDIA** LD R01,A ;execute: R01=09H



LDIA i

Load i to ACC operation:

period:

affected flag bit:

None

example:

0AH **LDIA** ; load 0AH to ACC

NOP

operation: **Empty instructions**

period:

affected flag

bit:

None

example:

NOP NOP

i

1

1

Ζ

ORIA

Perform 'OR' on I and ACC, save the result to ACC operation:

period: affected flag bit:

Ζ

example:

LDIA 0AH ;load 0AH to ACC

ORIA 030H ;execute: ACC =(0AH or 30H)=3AH

ORA [R]

Perform 'OR' on R and ACC, save the result to ACC operation:

period: affected flag bit:

example:

;load 0AH to ACC LDIA 0AH ;load ACC (0AH) to R01 R01,A

LD ;load 30H to ACC **LDIA** 30H

ORA R01 ;execute: ACC=(0AH or 30H)=3AH

ORR [R]

Perform 'OR' on R and ACC, save the result to R operation:

period: 1 affected flag Z

bit:

example:

;load 0AH to ACC LDIA 0AH

;load ACC (0AH) to R01 LD R01.A

;load 30H to ACC **LDIA** 30H

ORR R01 ;execute: R01=(0AH or 30H)=3AH



RET

operation: Return from subroutine

period:

affected flag bit:

None

example:

;call subroutine LOOP LOOP **CALL**

NOP ;this statement will be executed after RET instructions return

;others

LOOP:

;subroutine **RET** ;return

RET

operation: Return with parameter from the subroutine, and put the parameter in ACC

period:

affected flag

None bit:

example:

;call subroutine LOOP **CALL** LOOP

;this statement will be executed after RET instructions return NOP

;others

LOOP:

;subroutine

;return, ACC=35H **RET** 35H

RETI

operation: Interrupt return

2 period:

affected None flag bit:

example:

INT_START ;interrupt entrance

> ;interrupt procedure **RETI** ;interrupt return

RLCA [R]

operation: Register R rotates to the left with C and save the result into ACC

period: 1 affected flag С bit:

example:

03H ;load 03H to ACC **LDIA**

LD R01,A ;load ACC to R01, R01=03H ;operation result: ACC=06H(C=0); **RLCA** R01

ACC=07H(C=1)

C=0



RLCR [R]

operation: Register R rotates one bit to the left with C, and save the result into R

period: 1

affected flag bit:

С

example:

LDIA 03H ;load 03H to ACC

LD R01,A ;load ACC to R01, R01=03H RLCR R01 ;operation result: R01=06H(C=0);

R01=07H(C=1);

C=0

RLA [R]

operation: Register R without C rotates to the left, and save the result into ACC

period:

affected flag

bit:

None

1

example:

LDIA 03H ;load 03H to ACC

LD R01,A ;load ACC to R01, R01=03H RLA R01 ;operation result: ACC=06H

RLR [R]

operation: Register R without C rotates to the left, and save the result to R

period:

affected flag

bit:

None

example:

LDIA 03H ;load 03H to ACC

LD R01,A ;load ACC to R01, R01=03H RLR R01 ;operation result: R01=06H

RRCA [R]

operation: Register R rotates one bit to the right with C, and puts the result into ACC

period: 1 affected flag

bit:

example:

03H

LDIA

LD R01,A ;load ACC to R01, R01=03H RRCA R01 ;operation result: ACC=01H(C=0);

ACC=081H(C=1);

C=1

;load 03H to ACC





RRCR [R]

operation: Register R rotates one bit to the right with C, and save the result into R

period: 1 affected flag

С

example:

bit:

LDIA 03H ;load 03H to ACC

LD R01,A ;load ACC to R01, R01=03H RRCR R01 ;operation result: R01=01H(C=0);

R01=81H(C=1);

C=1

RRA [R]

operation: Register R without C rotates one bit to the right, and save the result into ACC

period: affected flag 1 None

example:

LDIA 03H ;load 03H to ACC

LD R01,A ;load ACC to R01, R01=03H RRA R01 ;operation result: ACC=81H

RRR [R]

operation: Register R without C rotates one bit to the right, and save the result into R

period: 1

affected flag

bit:

None

example:

LDIA 03H ;load 03H to ACC

LD R01,A ;load ACC to R01, R01=03H RRR R01 ;operation result: R01=81H

SET [R]

operation: Set all bits in register R as 1

period: 1

affected flag

bit:

None

example:

SET R01 ;operation result: R01=0FFH

SETB [R],b

operation: Set b bit in register R to 1

period: 1

affected flag

bit:

None

example:

CLR R01 ;R01=0

SETB R01,3 ;operation result: R01=08H





STOP

operation: Enter sleep

period:

affected flag bit:

TO, PD

example:

;the chip enters the power saving mode, the CPU and oscillator stop STOP

working, and the IO port keeps the original state

SUBIA i

I minus ACC, save the result to ACC operation:

period:

affected flag

bit:

C,DC,Z,OV

example:

LDIA 077H ;load 77H to ACC

SUBIA 80H ;operation result: ACC=80H-77H=09H

SUBA [R]

operation: Register R minus ACC, save the result to ACC

period:

affected flag

C,DC,Z,OV

bit:

example:

LDIA H080 ;load 80H to ACC

LD R01,A ;load ACC to R01, R01=80H

LDIA 77H ;load 77H to ACC

SUBA R01 ;operation result: ACC=80H-77H=09H

SUBR [R]

operation: Register R minus ACC, save the result to R

period:

affected flag

bit:

C,DC,Z,OV

example:

LDIA 080H ;load 80H to ACC

R01,A ;load ACC to R01, R01=80H LD

;load 77H to ACC 77H **LDIA**

SUBR R01 ;operation result: R01=80H-77H=09H



SUBCA [R]

operation: Register R minus ACC minus C, save the result to ACC

period:

affected flag bit:

C,DC,Z,OV

example:

LDIA 080H ; load 80H to ACC

LD R01,A ; load ACC to R01, R01=80H

LDIA 77H ; load 77H to ACC

SUBCA R01 ;operation result: ACC=80H-77H-C=09H(C=0);

ACC=80H-77H-C=08H(C=1);

SUBCR [R]

operation: Register R minus ACC minus C, the result is put into R

period: 1

affected flag

C,DC,Z,OV

example:

bit:

LDIA 080H ;load 80H to ACC

LD R01,A ;load ACC to R01, R01=80H

LDIA 77H ;load 77H to ACC

SUBCR R01 ;operation result: R01=80H-77H-C=09H(C=0)

R01=80H-77H-C=08H(C=1)

SWAPA [R]

operation: Register R high and low half byte swap, the save result into ACC

period: 1

affected flag

bit:

None

example:

LDIA 035H ;load 35H to ACC

LD R01,A ;load ACC to R01, R01=35H SWAPA R01 ;operation result: ACC=53H

SWAPR [R]

operation: Register R high and low half byte swap, the save result into R

period: 1

affected flag

bit:

None

example:

LDIA 035H ;load 35H to ACC

LD R01,A ;load ACC to R01, R01=35H SWAPR R01 ;operation result: R01=53H



SZB [R],b

operation: Determine the bit b of register R, if it is 0 then jump, otherwise execute in sequence

period: 1 or 2

affected flag

None

example:

SZB R01,3 ;determine 3rd bit of R01

JP LOOP ;if is 1, execute, jump to LOOP

JP LOOP1 ;if is 0, jump, execute, jump to LOOP1

SNZB [R],b

operation: Determine the bit b of register R, if it is 1 then jump, otherwise execute in sequence

period: 1 or 2

affected flag

None

example:

bit:

SNZB R01,3 ;determine 3rd bit of R01

JP LOOP ;if is 0, execute, jump to LOOP

JP LOOP1 ;if is 1, jump, execute, jump to LOOP1

SZA [R]

operation: Load the value of R to ACC, if it is 0 then jump, otherwise execute in sequence

period: 1 or 2 affected flag
None

bit:

example:

SZA R01 ;R01→ACC

JP LOOP ;if R01 is not 0, execute, jump to LOOP

JP LOOP1 ;if R01 is 0, jump, execute, jump to LOOP1

SZR [R]

operation: Load the value of R to R, if it is 0 then jump, otherwise execute in sequence

period: 1 or 2 affected flag

bit:

None

example:

SZR R01 ;R01→R01

JP LOOP ;if R01 is not 0, execute, jump to LOOP

JP LOOP1 ;if R01 is 0, jump, execute, jump to LOOP1



SZINCA [R]

Increment register by 1, save the result to ACC, if it is 0 then jump, otherwise execute in sequence operation:

period: affected flag

1 or 2 None

example:

SZINCA R01 :R01+1→ACC

JΡ LOOP ;if ACC is not 0, execute, jump to LOOP JΡ LOOP1 ;if ACC is 0, jump, execute, jump to LOOP1

SZINCR [R]

operation: Increment register by 1, save the result to R, if it is 0 then jump, otherwise execute in sequence

period: affected flag

bit:

None

1 or 2

example:

SZINCR R01 ;R01+1→R01

JΡ LOOP ;if R01 is not 0, execute, jump to LOOP JΡ LOOP1 ;if R01 is 0, jump, execute, jump to LOOP1

SZDECA [R]

operation: decrement register by 1, save the result to ACC, if it is 0 then jump, otherwise execute in sequence

period: 1 or 2 affected flag None

bit:

example:

R01 **SZDECA** :R01-1→ACC

JΡ LOOP ;if ACC is not 0, execute, jump to LOOP JΡ LOOP1 ;if ACC is 0, jump, execute, jump to LOOP1

SZDECR [R]

operation: Decrement register by 1, save the result to R, if it is 0 then jump, otherwise execute in sequence

period: affected flag 1 or 2

None

bit:

example:

SZDECR R01 ;R01-1→R01

JΡ LOOP ;if R01 is not 0, execute, jump to LOOP JΡ LOOP1 ;if R01 is 0, jump, execute, jump to LOOP1

ORG 0115H 1234H DW



[R]

1

Z

TESTZ

Pass the R to R, as affected Z flag bit operation:

period: affected flag

example:

bit:

;Pass the value of register R0 to R0, which is used to influence the **TESTZ** R0

Z flag bit

SZB STATUS,Z ;check Z flag bit, if it is 0 then jump JΡ Add1 ;if R0 is 0, jump to address Add1 JΡ Add2 ;if R0 is not 0, jump to address Add2

XORIA

Perform 'XOR' on I and ACC, save the result to ACC operation:

period: 1 affected flag Ζ bit:

example:

LDIA 0AH ;load 0AH to ACC

XORIA 0FH ;execute: ACC=05H

XORA [R]

Perform 'XOR' on I and ACC, save the result to ACC operation:

period: 1 affected flag Z bit:

example:

LDIA 0AH ;load 0AH to ACC

R01,A ;load ACC to R01, R01=0AH LD

0FH :load 0FH to ACC LDIA **XORA** ;execute: ACC=05H R01

XORR [R]

Perform 'XOR' on R and ACC, save the result to R operation:

period: 1 affected flag bit: example:

Ζ

0AH ;load 0AH to ACC **LDIA**

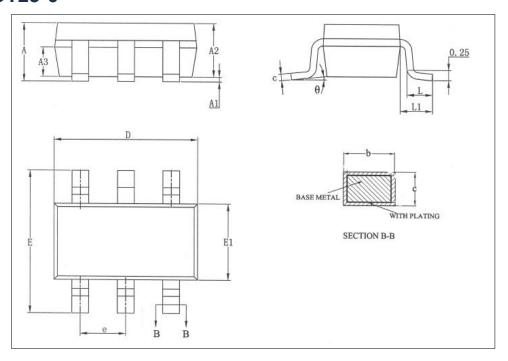
LD R01,A ;load ACC to R01, R01=0AH

LDIA 0FH ;load 0FH to ACC **XORR** R01 ;execute: R01=05H



14. Package

14.1 SOT23-6

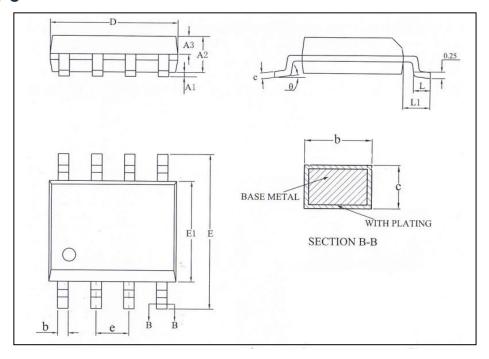


Currele el		Millimeter	
Symbol	Min	Nom	Max
Α	1	-	1.35
A1	0.01	-	0.15
A2	0.90	-	1.20
A3	0.55	-	0.80
b	0.30	-	0.50
С	0.12	-	0.21
D	2.77	-	3.07
E	2.65	2.80	3.00
E1	1.40	1.60	1.80
е		0.95BSC	
L	0.30	-	0.60
L1	0.52	-	0.75
θ	0	-	8°

注意: 封装尺寸不包括模的毛边凸起或门毛刺。



14.2 SOP8

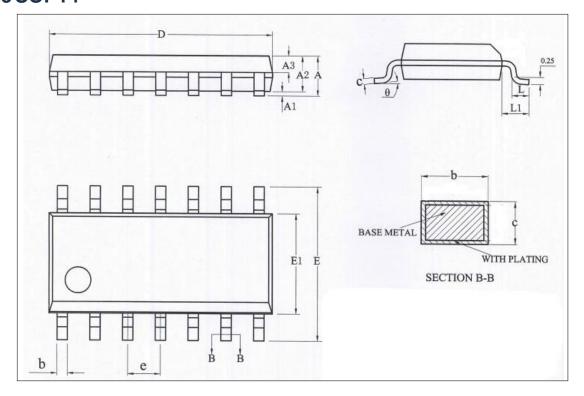


Comple of		Millimeter	
Symbol	Min	Nom	Max
A1	0.05	-	0.25
A2	1.30	1.40	1.60
A3	0.55	-	0.70
b	0.33	-	0.51
С	0.17	-	0.26
D	4.70	-	5.10
Е	5.80	6.00	6.20
E1	3.70	-	4.10
е		1.27BSC	
L	0.40	-	0.80
L1		1.05REF	
θ	0	-	8°

注意: 封装尺寸不包括模的毛边凸起或门毛刺。



14.3 SOP14

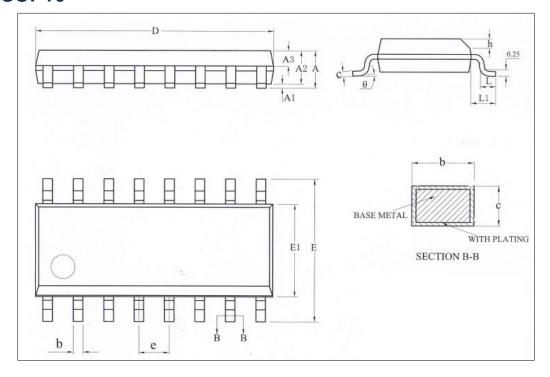


Symbol	Millimeter		
	Min	Nom	Max
А	-	-	1.85
A1	0.05	-	0.25
A2	1.30	-	1.60
A3	0.60	0.65	0.70
b	0.356	-	0.47
С	0.193	-	0.26
D	8.45	-	8.85
Е	5.80	6.00	6.20
E1	3.70	-	4.10
е	1.27BSC		
L	0.40	-	0.80
L1	1.05REF		
θ	0	-	8°

注意: 封装尺寸不包括模的毛边凸起或门毛刺。



14.4 SOP16



Symbol	Millimeter		
	Min	Nom	Max
А	-	-	1.85
A1	0.05	-	0.25
A2	1.30	-	1.60
A3	0.60	-	0.71
b	0.356	-	0.51
С	0.20	-	0.26
D	9.70	-	10.10
Е	5.80	6.00	6.20
E1	3.70	-	4.10
е	1.27BSC		
h	0.25	-	0.50
L	0.40	-	0.80
L1	1.05REF		
θ	0	-	8°

注意: 封装尺寸不包括模的毛边凸起或门毛刺。



15. Revision History

Version	Date	Revision content
V1.0.0	February 2023	Initial version
V1.0.1	January 2024 Modified some parameters in section 12.3 Comparator characteristics	
V1.0.2	September 2024	Revised the cover page